ST

Sitronix

ST7545T

66 x 102 Dot Matrix LCD Controller/Driver

1. INTRODUCTION

The ST7545T is a driver & controller LSI for graphic dot-matrix liquid crystal display systems. It contains 102 segments and 65 commons with 1 ICON driver circuits. This chip is connected directly to a microprocessor, accepts 8-bit parallel interface、3-line or 4-line serial peripheral interface (SPI)、I^2C interface, display data can stores in an on-chip display data RAM of 66 x 102 bits. It performs display data RAM read/write operation with no external operating clock to minimize power consumption. In addition, because it contains power supply circuits to drive liquid crystal, it is possible to make a display system with the fewest components.

2. FEATURES

Single-chip LCD controller & driver

Driver Output Circuits

102-segment x 65-common + 1 ICON

On-chip Display Data ram

- Capacity: 66X102=6,732 bits

Microprocessor Interface

- 8-bit parallel bi-directional interface with 6800-series or 8080-series

- 4-line SPI (serial peripheral interface) available (only write operation)

- 3-line SPI (serial peripheral interface) available

- I^2C (Inter-Integrated Circuit) Interface

On-chip Low Power Analog Circuit

- Generation of LCD supply voltage (external V_{OUT} voltage supply is supported)

- Generation of intermediate LCD bias voltages

- Oscillator requires no external components (external clock also supported)

- Voltage Booster (x4, x5)

- Voltage regulator(temperature gradient -0.11%/°C)

- Voltage follower

- On-chip electronic contrast control function (128 steps)

External RESB (reset) pin

Supply voltage range

- V_{DD1} -V_{SS} : 1.7 to 3.3V

- V_{DD2} -V_{SS} : 2.4 to 3.3V

- V_{OUTIN} -V_{SS} : 13.5V (max)

Temperature range: -30 to +85 degree

ST7545T-G2	**6800 , 8080 , 4-Line , 3-Line interface (without I^2C interface)**	**ST**
ST7545Ti-G2	I^2C interface	I^2C BUS

3. ST7545T-G2 Pad Arrangement (COG)

Chip Size: 8,200 um × 1020 um

Bump Pitch:

PAD NO 1 ~ 11 , 12 ~ 147 , 207 ~ 230 : 55 um ;   PAD NO 11 ~ 12 : 56 um ;

PAD NO 148 ~ 216 : max : 175 um , min : 72 um

Bump Size:

PAD NO 188 ~ 193 : 45 (x)um × 60 (y) um   ;

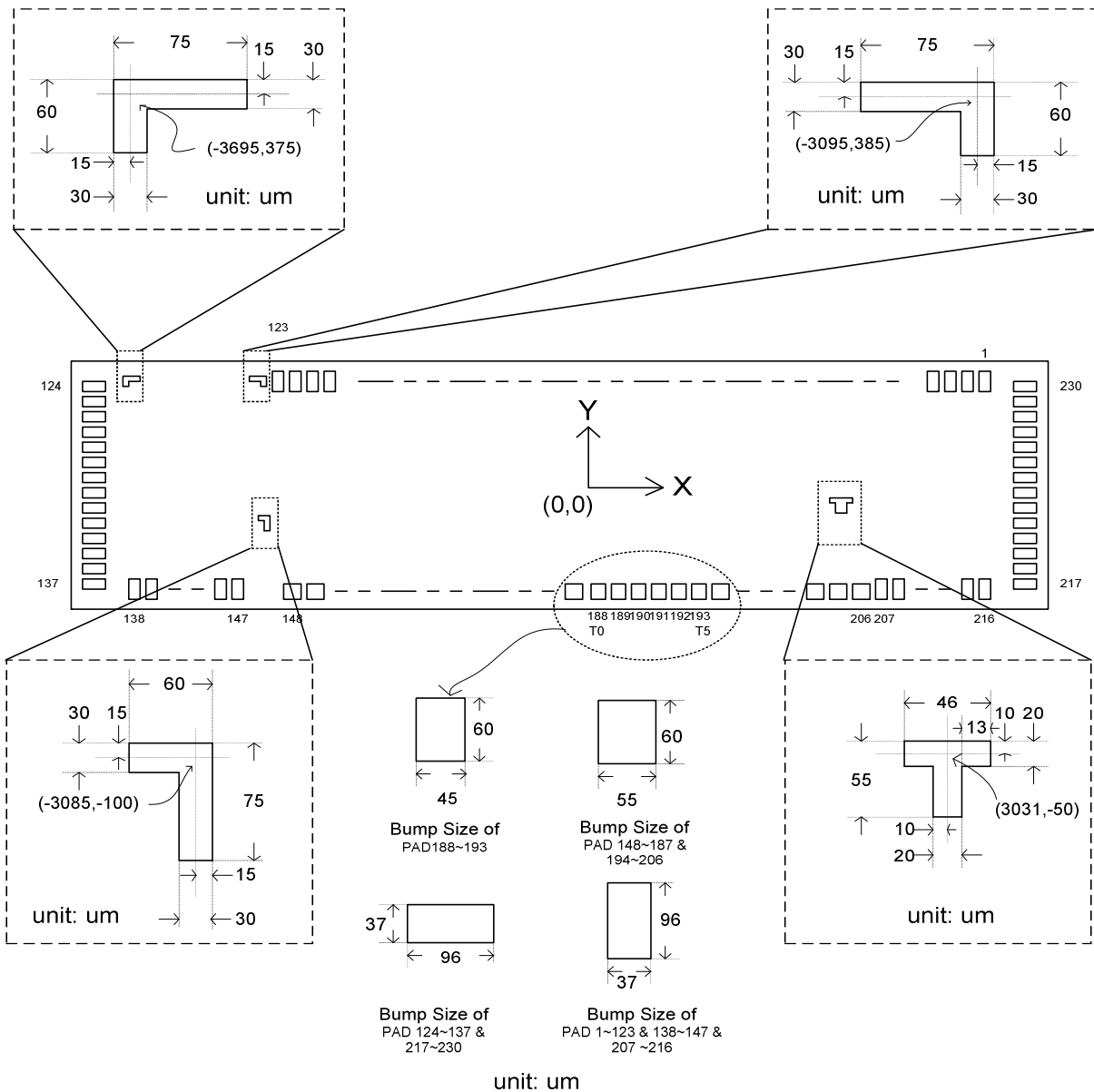**PAD NO 148 ~ 187 , 194 ~ 206 : 55 (x) um × 60 (y) um   ;**

PAD NO 124 ~ 137 , 217 ~ 230: 96 (x) um × 37 (y) um   ;

PAD NO 1 ~ 123 , 138 ~ 147 , 207 ~ 216 :   37 (x) um × 96 (y) um   ;

Bump Height: 17 um

Chip Thickness: 480 um

Bump Size of PAD188~193

Bump Size of PAD 148~187 & 194~206

Bump Size of PAD 124~137 & 217~230

Bump Size of PAD 1~123 & 138~147 & 207 ~216

unit: um

Pad Center Coordinates (TMY=0)

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
1	COM[41]	3677	371	31	SEG[19]	2026	371
2	COM[40]	3622	371	32	SEG[20]	1971	371
3	COM[39]	3567	371	33	SEG[21]	1916	371
4	COM[38]	3512	371	34	SEG[22]	1861	371
5	COM[37]	3457	371	35	SEG[23]	1806	371
6	COM[36]	3402	371	36	SEG[24]	1751	371
7	COM[35]	3347	371	37	SEG[25]	1696	371
8	COM[34]	3292	371	38	SEG[26]	1641	371
9	COM[33]	3237	371	39	SEG[27]	1586	371
10	COM[32]	3182	371	40	SEG[28]	1531	371
11	Reserved	3127	371	41	SEG[29]	1476	371
12	SEG[0]	3071	371	42	SEG[30]	1421	371
13	SEG[1]	3016	371	43	SEG[31]	1366	371
14	SEG[2]	2961	371	44	SEG[32]	1311	371
15	SEG[3]	2906	371	45	SEG[33]	1256	371
16	SEG[4]	2851	371	46	SEG[34]	1201	371
17	SEG[5]	2796	371	47	SEG[35]	1146	371
18	SEG[6]	2741	371	48	SEG[36]	1091	371
19	SEG[7]	2686	371	49	SEG[37]	1036	371
20	SEG[8]	2631	371	50	SEG[38]	981	371
21	SEG[9]	2576	371	51	SEG[39]	926	371
22	SEG[10]	2521	371	52	SEG[40]	871	371
23	SEG[11]	2466	371	53	SEG[41]	816	371
24	SEG[12]	2411	371	54	SEG[42]	761	371
25	SEG[13]	2356	371	55	SEG[43]	706	371
26	SEG[14]	2301	371	56	SEG[44]	651	371
27	SEG[15]	2246	371	57	SEG[45]	596	371
28	SEG[16]	2191	371	58	SEG[46]	541	371
29	SEG[17]	2136	371	59	SEG[47]	486	371
30	SEG[18]	2081	371	60	SEG[48]	431	371

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
61	SEG[49]	376	371	91	SEG[79]	-1274	371
62	SEG[50]	321	371	92	SEG[80]	-1329	371
63	SEG[51]	266	371	93	SEG[81]	-1384	371
64	SEG[52]	211	371	94	SEG[82]	-1439	371
65	SEG[53]	156	371	95	SEG[83]	-1494	371
66	SEG[54]	101	371	96	SEG[84]	-1549	371
67	SEG[55]	46	371	97	SEG[85]	-1604	371
68	SEG[56]	-9	371	98	SEG[86]	-1659	371
69	SEG[57]	-64	371	99	SEG[87]	-1714	371
70	SEG[58]	-119	371	100	SEG[88]	-1769	371
71	SEG[59]	-174	371	101	SEG[89]	-1824	371
72	SEG[60]	-229	371	102	SEG[90]	-1879	371
73	SEG[61]	-284	371	103	SEG[91]	-1934	371
74	SEG[62]	-339	371	104	SEG[92]	-1989	371
75	SEG[63]	-394	371	105	SEG[93]	-2044	371
76	SEG[64]	-449	371	106	SEG[94]	-2099	371
77	SEG[65]	-504	371	107	SEG[95]	-2154	371
78	SEG[66]	-559	371	108	SEG[96]	-2209	371
79	SEG[67]	-614	371	109	SEG[97]	-2264	371
80	SEG[68]	-669	371	110	SEG[98]	-2319	371
81	SEG[69]	-724	371	111	SEG[99]	-2374	371
82	SEG[70]	-779	371	112	SEG[100]	-2429	371
83	SEG[71]	-834	371	113	SEG[101]	-2484	371
84	SEG[72]	-889	371	114	COMS	-2540	371
85	SEG[73]	-944	371	115	COM[0]	-2595	371
86	SEG[74]	-999	371	116	COM[1]	-2650	371
87	SEG[75]	-1054	371	117	COM[2]	-2705	371
88	SEG[76]	-1109	371	118	COM[3]	-2760	371
89	SEG[77]	-1164	371	119	COM[4]	-2815	371
90	SEG[78]	-1219	371	120	COM[5]	-2870	371

PAD NO.	PIN Name	X	Y		PAD NO.	PIN Name	X	Y
121	COM[6]	-2925	371		151	VDD1	-1929	-389
122	COM[7]	-2980	371		152	VDD1	-1856	-389
123	COM[8]	-3035	371		153	VDD1	-1783	-389
124	COM[9]	-3981	352		154	PS0	-1710	-389
125	COM[10]	-3981	297		155	PS1	-1591	-389
126	COM[11]	-3981	242		156	PS2	-1518	-389
127	COM[12]	-3981	187		157	BR	-1399	-389
128	COM[13]	-3981	132		158	VSS	-1326	-389
129	COM[14]	-3981	77		159	T6	-1253	-389
130	COM[15]	-3981	22		160	T7	-1134	-389
131	COM[16]	-3981	-33		161	CP	-1061	-389
132	COM[17]	-3981	-88		162	T8	-942	-389
133	COM[18]	-3981	-143		163	T9	-869	-389
134	COM[19]	-3981	-198		164	VDD2	-766	-389
135	COM[20]	-3981	-253		165	VDD2	-693	-389
136	COM[21]	-3981	-308		166	VDD2	-620	-389
137	COM[22]	-3981	-363		167	VDD2	-547	-389
138	COM[23]	-3678	-371		168	RESB	-410	-389
139	COM[24]	-3623	-371		169	CSB	-291	-389
140	COM[25]	-3568	-371		170	/WR	-218	-389
141	COM[26]	-3513	-371		171	/RD	-99	-389
142	COM[27]	-3458	-371		172	A0	-26	-389
143	COM[28]	-3403	-371		173	VDD1	77	-389
144	COM[29]	-3348	-371		174	D7	150	-389
145	COM[30]	-3293	-371		175	D6	269	-389
146	COM[31]	-3238	-371		176	D5	342	-389
147	Reserved	-3183	-371		177	D4	461	-389
148	TMX	-2194	-389		178	D3	534	-389
149	TMY	-2075	-389		179	D2	653	-389
150	VDD1	-2002	-389		180	D1	726	-389

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
181	D0	845	-389	211	COM[61]	3403	-371
182	OSC	918	-389	212	COM[60]	3458	-371
183	VSS	1021	-389	213	COM[59]	3513	-371
184	VSS	1094	-389	214	COM[58]	3568	-371
185	VSS	1167	-389	215	COM[57]	3623	-371
186	VSS	1240	-389	216	COM[56]	3678	-371
187	VRS	1313	-389	217	COM[55]	3981	-363
188	T0	1385	-389	218	COM[54]	3981	-308
189	T1	1534	-389	219	COM[53]	3981	-253
190	T2	1609	-389	220	COM[52]	3981	-198
191	T3	1784	-389	221	COM[51]	3981	-143
192	T4	1859	-389	222	COM[50]	3981	-88
193	T5	2034	-389	223	COM[49]	3981	-33
194	VSS	2108	-389	224	COM[48]	3981	22
195	VSS	2181	-389	225	COM[47]	3981	77
196	VSS	2254	-389	226	COM[46]	3981	132
197	VSS	2327	-389	227	COM[45]	3981	187
198	V_{OUTOUT}	2415	-389	228	COM[44]	3981	242
199	V_{OUTOUT}	2488	-389	229	COM[43]	3981	297
200	V_{OUTIN}	2561	-389	230	COM[42]	3981	352
201	V_{OUTIN}	2634	-389				
202	V0	2793	-389				
203	V1	2883	-389				
204	V2	2956	-389				
205	V3	3029	-389				
206	V4	3102	-389				
207	COMS	3183	-371				
208	COM[64]	3238	-371				
209	COM[63]	3293	-371				
210	COM[62]	3348	-371				

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Pad Center Coordinates(TMY=1)

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
1	COM[23]	3677	371	31	SEG[19]	2026	371
2	COM[24]	3622	371	32	SEG[20]	1971	371
3	COM[25]	3567	371	33	SEG[21]	1916	371
4	COM[26]	3512	371	34	SEG[22]	1861	371
5	COM[27]	3457	371	35	SEG[23]	1806	371
6	COM[28]	3402	371	36	SEG[24]	1751	371
7	COM[29]	3347	371	37	SEG[25]	1696	371
8	COM[30]	3292	371	38	SEG[26]	1641	371
9	COM[31]	3237	371	39	SEG[27]	1586	371
10	Reserved	3182	371	40	SEG[28]	1531	371
11	Reserved	3127	371	41	SEG[29]	1476	371
12	SEG[0]	3071	371	42	SEG[30]	1421	371
13	SEG[1]	3016	371	43	SEG[31]	1366	371
14	SEG[2]	2961	371	44	SEG[32]	1311	371
15	SEG[3]	2906	371	45	SEG[33]	1256	371
16	SEG[4]	2851	371	46	SEG[34]	1201	371
17	SEG[5]	2796	371	47	SEG[35]	1146	371
18	SEG[6]	2741	371	48	SEG[36]	1091	371
19	SEG[7]	2686	371	49	SEG[37]	1036	371
20	SEG[8]	2631	371	50	SEG[38]	981	371
21	SEG[9]	2576	371	51	SEG[39]	926	371
22	SEG[10]	2521	371	52	SEG[40]	871	371
23	SEG[11]	2466	371	53	SEG[41]	816	371
24	SEG[12]	2411	371	54	SEG[42]	761	371
25	SEG[13]	2356	371	55	SEG[43]	706	371
26	SEG[14]	2301	371	56	SEG[44]	651	371
27	SEG[15]	2246	371	57	SEG[45]	596	371
28	SEG[16]	2191	371	58	SEG[46]	541	371
29	SEG[17]	2136	371	59	SEG[47]	486	371
30	SEG[18]	2081	371	60	SEG[48]	431	371

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
61	SEG[49]	376	371	91	SEG[79]	-1274	371
62	SEG[50]	321	371	92	SEG[80]	-1329	371
63	SEG[51]	266	371	93	SEG[81]	-1384	371
64	SEG[52]	211	371	94	SEG[82]	-1439	371
65	SEG[53]	156	371	95	SEG[83]	-1494	371
66	SEG[54]	101	371	96	SEG[84]	-1549	371
67	SEG[55]	46	371	97	SEG[85]	-1604	371
68	SEG[56]	-9	371	98	SEG[86]	-1659	371
69	SEG[57]	-64	371	99	SEG[87]	-1714	371
70	SEG[58]	-119	371	100	SEG[88]	-1769	371
71	SEG[59]	-174	371	101	SEG[89]	-1824	371
72	SEG[60]	-229	371	102	SEG[90]	-1879	371
73	SEG[61]	-284	371	103	SEG[91]	-1934	371
74	SEG[62]	-339	371	104	SEG[92]	-1989	371
75	SEG[63]	-394	371	105	SEG[93]	-2044	371
76	SEG[64]	-449	371	106	SEG[94]	-2099	371
77	SEG[65]	-504	371	107	SEG[95]	-2154	371
78	SEG[66]	-559	371	108	SEG[96]	-2209	371
79	SEG[67]	-614	371	109	SEG[97]	-2264	371
80	SEG[68]	-669	371	110	SEG[98]	-2319	371
81	SEG[69]	-724	371	111	SEG[99]	-2374	371
82	SEG[70]	-779	371	112	SEG[100]	-2429	371
83	SEG[71]	-834	371	113	SEG[101]	-2484	371
84	SEG[72]	-889	371	114	COMS	-2540	371
85	SEG[73]	-944	371	115	COM[64]	-2595	371
86	SEG[74]	-999	371	116	COM[63]	-2650	371
87	SEG[75]	-1054	371	117	COM[62]	-2705	371
88	SEG[76]	-1109	371	118	COM[61]	-2760	371
89	SEG[77]	-1164	371	119	COM[60]	-2815	371
90	SEG[78]	-1219	371	120	COM[59]	-2870	371

PAD NO.	PIN Name	X	Y		PAD NO.	PIN Name	X	Y
121	COM[58]	-2925	371		151	VDD1	-1929	-389
122	COM[57]	-2980	371		152	VDD1	-1856	-389
123	COM[56]	-3035	371		153	VDD1	-1783	-389
124	COM[55]	-3981	352		154	PS0	-1710	-389
125	COM[54]	-3981	297		155	PS1	-1591	-389
126	COM[53]	-3981	242		156	PS2	-1518	-389
127	COM[52]	-3981	187		157	BR	-1399	-389
128	COM[51]	-3981	132		158	VSS	-1326	-389
129	COM[50]	-3981	77		159	T6	-1253	-389
130	COM[49]	-3981	22		160	T7	-1134	-389
131	COM[48]	-3981	-33		161	CP	-1061	-389
132	COM[47]	-3981	-88		162	T8	-942	-389
133	COM[46]	-3981	-143		163	T9	-869	-389
134	COM[45]	-3981	-198		164	VDD2	-766	-389
135	COM[44]	-3981	-253		165	VDD2	-693	-389
136	COM[43]	-3981	-308		166	VDD2	-620	-389
137	COM[42]	-3981	-363		167	VDD2	-547	-389
138	COM[41]	-3678	-371		168	RESB	-410	-389
139	COM[40]	-3623	-371		169	CSB	-291	-389
140	COM[39]	-3568	-371		170	/WR	-218	-389
141	COM[38]	-3513	-371		171	/RD	-99	-389
142	COM[37]	-3458	-371		172	A0	-26	-389
143	COM[36]	-3403	-371		173	VDD1	77	-389
144	COM[35]	-3348	-371		174	D7	150	-389
145	COM[34]	-3293	-371		175	D6	269	-389
146	COM[33]	-3238	-371		176	D5	342	-389
147	COM[32]	-3183	-371		177	D4	461	-389
148	TMX	-2194	-389		178	D3	534	-389
149	TMY	-2075	-389		179	D2	653	-389
150	VDD1	-2002	-389		180	D1	726	-389

PAD NO.	PIN Name	X	Y	PAD NO.	PIN Name	X	Y
181	D0	845	-389	211	COM[3]	3403	-371
182	OSC	918	-389	212	COM[4]	3458	-371
183	VSS	1021	-389	213	COM[5]	3513	-371
184	VSS	1094	-389	214	COM[6]	3568	-371
185	VSS	1167	-389	215	COM[7]	3623	-371
186	VSS	1240	-389	216	COM[8]	3678	-371
187	VRS	1313	-389	217	COM[9]	3981	-363
188	T0	1385	-389	218	COM[10]	3981	-308
189	T1	1534	-389	219	COM[11]	3981	-253
190	T2	1609	-389	220	COM[12]	3981	-198
191	T3	1784	-389	221	COM[13]	3981	-143
192	T4	1859	-389	222	COM[14]	3981	-88
193	T5	2034	-389	223	COM[15]	3981	-33
194	VSS	2108	-389	224	COM[16]	3981	22
195	VSS	2181	-389	225	COM[17]	3981	77
196	VSS	2254	-389	226	COM[18]	3981	132
197	VSS	2327	-389	227	COM[19]	3981	187
198	V_{OUTOUT}	2415	-389	228	COM[20]	3981	242
199	V_{OUTOUT}	2488	-389	229	COM[21]	3981	297
200	V_{OUTIN}	2561	-389	230	COM[22]	3981	352
201	V_{OUTIN}	2634	-389				
202	V0	2793	-389				
203	V1	2883	-389				
204	V2	2956	-389				
205	V3	3029	-389				
206	V4	3102	-389				
207	COMS	3183	-371				
208	COM[0]	3238	-371				
209	COM[1]	3293	-371				
210	COM[2]	3348	-371				

4. BLOCK DIAGRAM

SEG0 TO SEG101   COM0 TO COM64+ICOM

SEGMENT DRIVERS   COMMON DRIVERS

BIAS VOLTAGE GENERATOR

COMMON OUTPUT CONTROLLER CIRCUIT

DATA LATCHES

V_{OUT_IN}

V_{OUT_OUT}

V_{LCD} GENERATOR

RESET   /RESB

DISPLAY DATA RAM (DDRAM) [66X102]

OSCILLATOR   OSC

TIMING GENERATOR

DISPLAY ADDRESS COUNTER

ADDRESS COUNTER

V_{DD1}

V_{DD2}

V_{SS}

DATA REGISTER   INSTRUCTION REGISTER

BUS HOLDER   INSTRUCTION DECODER

PS0

PS1

PS2

MPU INTERFACE(PARALLEL & SERIAL)

/RESB /CSB A0 /RD(E) WR(R/W) DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0

Fig.1 block diagram

5. PINNING DESCRIPTIONS

Pin Name	I/O	Description	No. of Pins
Lcd driver outputs			
SEG0 to SEG101	**O**	LCD segment driver outputs This display data and the M signal control the output voltage of segment driver. Segment driver output voltage table below	102
COM0 to COM64	**O**	LCD common driver outputs This internal scanning data and M signal control the output voltage of common driver. Common driver output voltage table below	65
COMS	**O**	Common output for the icons. The output signals of two pins are same. When not used, this pin should be left open.	2
MICROPROCESSOR INTERFACE			
PS[2:0]	**I**	Microprocessor interface select input pin PS table below	3
CSB	**I**	Chip select input pins Data/instruction I/O is enabled only when CSB is " L ". When chip select is non-active, DB0 to DB7 is high impedance. **This pin only be used in 8-bit parallel interface.** **When using serial interface , this pin must be fixed to "H"**	1
RESB	**I**	Reset input pin When RESB is " L ", initialization is executed.	1
A0	**I**	It determines whether the data bits are data or a command. A0=" H ": Indicates that D0 to D7 are display data. A0=" L ": Indicates that D0 to D7 are control data. **This pin only be used in 8-bit parallel interface.** **When using serial interface , this pin must be fixed to "H"**	1

SEG0 to SEG101 — Segment driver output voltage:

Display data	M (Internal)	Normal display	Reverse display
H	H	V_0	V_2
H	L	V_{SS}	V_3
L	H	V_2	V_0
L	L	V_3	V_{SS}
Power down mode		V_{SS}	V_{SS}

COM0 to COM64 — Common driver output voltage:

Display data	M(Internal)	Normal display	Reverse display
H	H	V_{SS}	
H	L	V_0	
L	H	V_1	
L	L	V_4	
Power down mode		V_{SS}	

PS[2:0] — Microprocessor interface select:

PS0	PS1	PS2	State
" L "	" L "	" L "	4 Pin-SPI MPU interface
" L "	" L "	" H "	3 Pin-SPI MPU interface
" L "	" H "	" L "	8080-series parallel MPU interface
" L "	" H "	" H "	6800-series parallel MPU interface
" H "	"H"	" H "	I^{2}C interface

		Read/Write execution control pin				
/WR(R/W)	I					**1**

Read/Write execution control pin

PS2	MPU type	/WR(R/W)	Description
H	6800-series	R/W	Read/Write control input pin R/W=" H ": read R/W=" L": write
L	8080-series	/WR	Write enable clock input pin The data on D0 to D7 are latched at the rising edge of the /WR signal

When in the serial interface must fix to " H"

/RD (E)	I		**1**

Read/Write execution control pin (PS[0:1]=[L:H])

PS2	MPU Type	/RD (E)	Description
H	6800-series	E	Read/Write control input pin R/W=" H ": When E is " H ", D0 to D7 are in an output status. R/W=" L ": The data on D0 to D7 are latched at the falling edge of the E signal.
L	8080-series	/RD	Read enable clock input pin When /RD is " L ", D0 to D7 are in an output status.

When in the serial interface must fix to " H"

D7(SCLK) D6(SDA) D5(A0) D4(CSB) D3 to D0			

When using 8-bit parallel interface: 6800 / 8080
8-bit bi-directional data bus that is connected to the standard 8-bit microprocessor data bus.
When chip select is not active, D0 to D7 is high impedance.

When using serial interface: 4-LINE / 3-LINE
D7: serial input clock (SCLK) ; D6: serial input data (SDA)
D5: command/data selection (A0) ; D4: chip select pin(CSB)
D3,D2.D1.D0: must fix to " H"
When using 3-line A0 must fix to "H"

D7(SCLK) D6 (SDA_IN) D5(X) D4(X) D3 to D2 (SDA_OUT) D1 (SA1) D0 (SA0)	I/O		**8**

When using I^{2}C interface
D7: serial clock input (SCLK)
D6: serial input data (SDA_IN)
D3, D2: (SDA_OUT) serial data acknowledge for the I^{2}C interface. By connecting SDA_OUT to SDA_IN externally, the SDA line becomes fully I^{2}C interface compatible. Having the acknowledge output separated from the serial data line is advantageous in chip on glass (COG) applications. In COG application where the track resistance from the SDA_OUT pad to the system SDA line can be significant, a potential divider is generated by the bus pull-up resistor and the ITO track resistance. It is possible that during the acknowledge cycle the ST7545T will not be able to create a valid logic 0 level. By splitting the SDA_IN input from the SDA_OUT output the device could be used in a mode that ignores the acknowledge bit. In COG applications where the acknowledge cycle is required, it is necessary to minimize the track resistance from the SDA_OUT pad to the system SDA line to guarantee a valid low level.
D6, D3,D2 must be connected together (SDA)
D4, D5: must fix to " H"
D1, D0: Are slave address (SA0,SA1), must fix to "H" or "L"
Chip select input pins "CSB" not used must fix to "H"

LCD DRIVER SUPPLY			
OSC	I	**When the on-chip oscillator is used, this input must be connected to VDD**. An external clock signal, if used, is connected to this input. If the oscillator and external clock are both inhibited by connecting the OSC pin to VSS the display is not clocked and may be left in a DC state. To avoid this, the chip should always be put into Power Down Mode before stopping the clock.	1
Power Supply Pins			
V_{SS}	**Power Supply**	Ground.	9
V_{DD1}	**Power Supply**	Digital Supply voltage. The 2 supply rails V_{DD1} and V_{DD2} could be connected together. If Digital Option pin is high, must be this level	5
V_{DD2}	**Power Supply**	Analog Supply voltage. The 2 supply rails V_{DD1} and V_{DD2} could be connected together.	4
V_{OUTIN}	**Power Supply**	This pad is the power source of the internal voltage regulator. If the internal voltage generator uses internal booster output, the V_{OUTIN} & V_{OUTOUT} must be connected together. If the internal voltage generator uses external booster, V_{OUTOUT} has to be left open and the external supply voltage can be supplied through the V_{OUTIN} pad.	2
V_{OUTOUT}	**Power Supply**	If the internal voltage booster is used, the V_{OUTIN} & V_{OUTOUT} must be connected together with one capacitor connected to VSS If an external supply is used this pin must be left open.	2
V0, V1, V2, V3, V4	**Power Supply**	This is a multi-level power supply for the liquid crystal. $V_{OUTIN} \geq V0 \geq V1 \geq V2 \geq V3 \geq V4 \geq VSS$	5
VRS	**Power Supply**	Monitor Voltage Regulator reference voltage level, must be left open.	1
Configuration Pins			
TMX	I	Mirror X: SEG bi-direction selection TMX connect to VSS : normal direction (SEG0→SEG101) TMX connect to VDD : reverse direction (SEG101→SEG0)	1
TMY	I	Mirror Y: COM bi-direction selection TMY connect to VSS (TMY=0): normal direction TMY connect to VDD (TMY=1): reverse direction See Pad Center Coordinates at page 3~10.	1
CP	I	Set Booster stages. (VSS=4X;VDD=5X)	1
BR	I	Set LCD bias ratio. (VSS=1/7;VDD=1/9) After reset, the bias ratio will be the setting value.	1
Test Pin			
T0~T9	T	T0~T5 must floating T7.T8 .T9 must connect to VDD T6 must connect to VSS	10
Reserved	-	All Reserved pins must floating	2

ST7545T

ST7545T I/O PIN ITO Resister Limitation

PIN Name	ITO Resister
PS[2:0], OSC, CP, BR, T6~T9, TMX, TMY	No Limitation
T0~T5, VRS, V1, V2, V3, V4	Floating
V_{DD1}, V_{DD2}, V_{SS}, V_{OUTIN}, V_{OUTOUT}	<100Ω
V0	<500Ω
A0, /WR, /RD, CSB, D0…D7	<1KΩ
RESB	<10KΩ

6. FUNCTIONS DESCRIPTION

MICROPROCESSOR INTERFACE

Chip Select Input

There is CSB pin for chip selection. The ST7545T can interface with an MPU when CSB is "L". When CSB is "H", these pins are set to any other combination, A0, /RD(E), and /WR(R/W) inputs are disabled and D0 to D7 are to be high impedance. And, in case of serial interface, the internal shift register and the counter are reset.

Parallel / Serial Interface

ST7545T has five types of interface with an MPU, which are three serial and two parallel interfaces. This parallel or serial interface is determined by PS [0:2] pin as shown in table 1.

Table 1. Parallel/Serial Interface Mode

PS0	PS1	PS2	State
" L "	" L "	" L "	4 Pin-SPI MPU interface
" L "	" L "	" H "	3 Pin-SPI MPU interface
" L "	" H "	" L "	8080-series parallel MPU interface
" L "	" H "	" H "	6800-series parallel MPU interface
" H "	" H "	" H "	I^{2}C interface

Parallel Interface

The 8-bit bi-directional data bus is used in parallel interface and the type of MPU is selected by PS2 as shown in table 2. The type of data transfer is determined by signals at A0, /RD (E) and /WR(R/W) as shown in table 3.

Table 2. Microprocessor Selection for Parallel Interface

PS0	PS1	PS2	CSB	A0	/RD (E)	/WR (R/W)	DB0 to DB7	MPU bus
L	H	H	CSB	A0	E	R/W	DB0 to DB7	6800-series
L	H	L	CSB	A0	/RD	/WR	DB0 to DB7	8080-series

Table 3. Parallel Data Transfer

| Common	6800-series		8080-series		Description
A0	E (/RD)	R/W (/WR)	/RD (E)	/WR (R/W)	
H	H	H	L	H	Display data read out
H	H	L	H	L	Display data write
L	H	H	L	H	Register status read
L	H	L	H	L	Writes to internal register (instruction)

NOTE: When /RD (E) pin is always pulled high for 6800-series interface, it can be used CSB for enable signal. In this case, interface data is latched at the rising edge of CSB and the type of data transfer is determined by signals at A0, /WR(R/W) as in case of 6800-series mode.

Serial Interface

| Serial Mode	PS0	PS1	PS2
4-line SPI interface	L	L	L
3-line SPI interface	L	L	H
I^{2}C interface	H	H	H

PS0=" L ", PS1=" L ", PS2=" L ": 4-line SPI interface

When the ST7545T is active (CSB="L"), serial data (D1) and serial clock (D0) inputs are enabled. And not active, the internal 8-bit shift register and the 3-bit counter are reset. The display data/command indication may be controlled either via software or the Register Select (A0) Pin, based on the setting of PS[2:0]. When the A0 pin is used , data is display data when A0 is high, and command data when A0 is low. When A0 is not used , the LCD Driver will receive command from MCU by default. If messages on the data pin are data rather than command, MCU should send Data direction command to control the data direction and then one more command to define the number of data bytes will be write. After these two continuous commands are sending, the following messages will be data rather than command. Serial data can be read on the rising edge of serial clock going into D0 and processed as 8-bit parallel data on the eighth serial clock. And the DDRAM column address pointer will be increased by one automatically. The next bytes after the display data string are handled as command data.
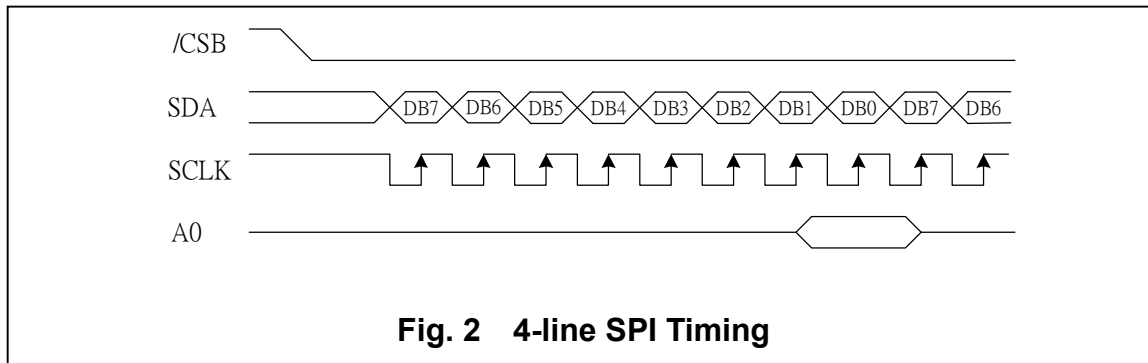
Fig. 2   4-line SPI Timing

PS0=" L ", PS1=" L ", PS2=" H ": 3-line SPI interface
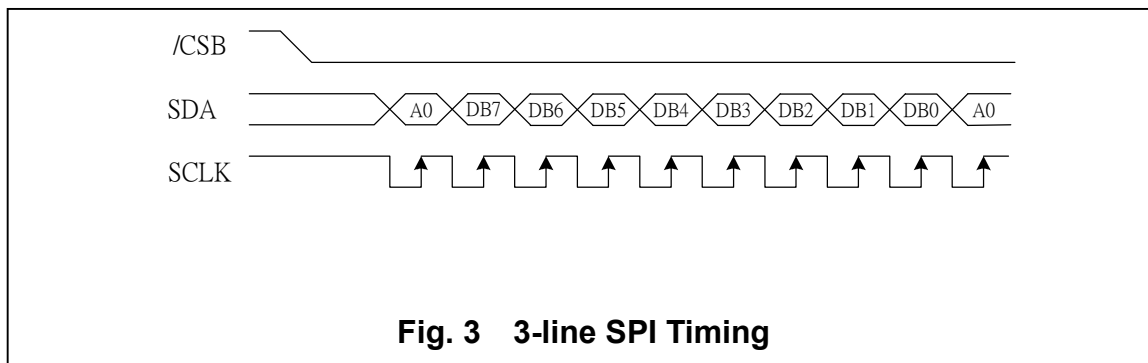
Fig. 3   3-line SPI Timing

ST7545T

PS0="H", PS1="H", PS2="H": I²C Interface

The I²C interface receives and executes the commands sent via the I²C Interface. It also receives RAM data and sends it to the RAM. The I²C Interface is for bi-directional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock line (SCLK). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

BIT TRANSFER

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse because changes on the data line at this time will be interpreted as a control signal. Bit transfer is illustrated in Fig.4.

START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in Fig.5.
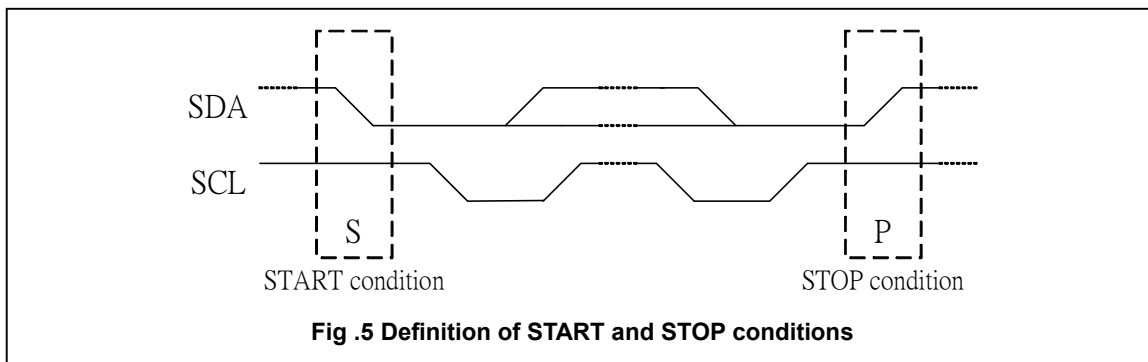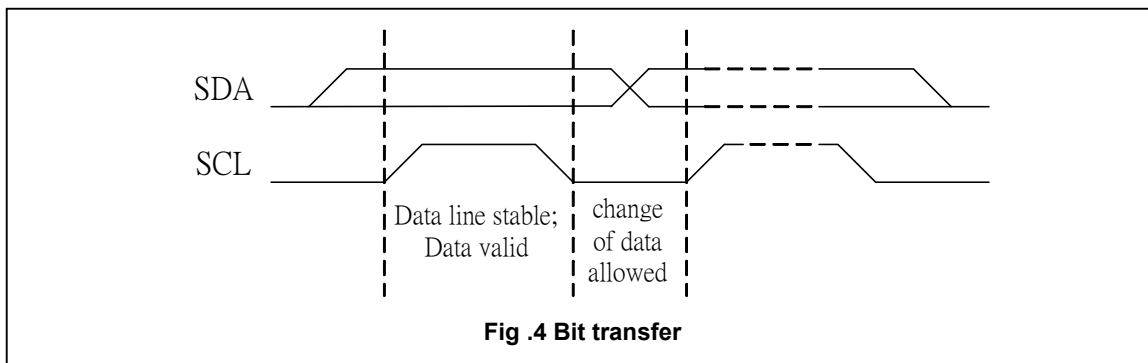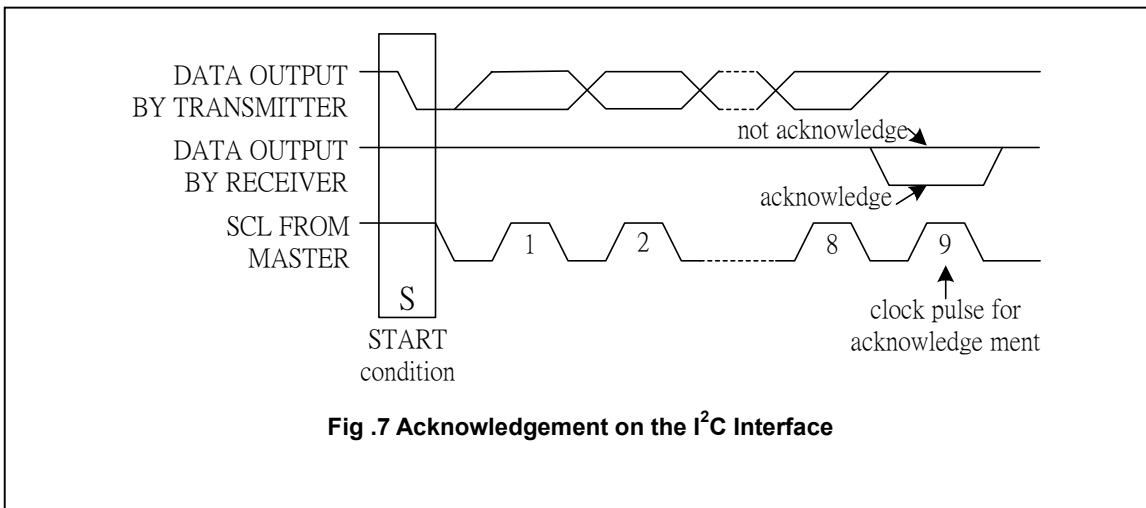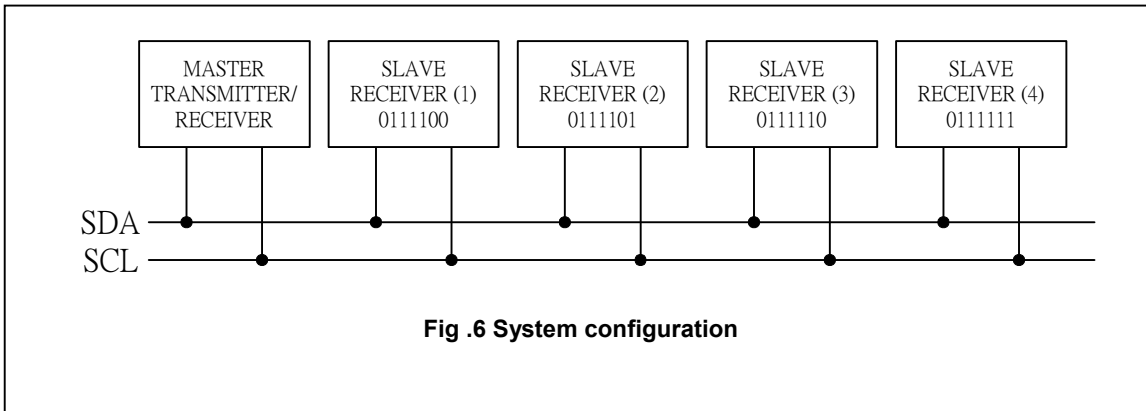
SYSTEM CONFIGURATION

The system configuration is illustrated in Fig.6.
· Transmitter: the device, which sends the data to the bus
· Receiver: the device, which receives the data from the bus
· Master: the device, which initiates a transfer, generates clock signals and terminates a transfer
· Slave: the device addressed by a master
· Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message
· Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
· Synchronization: procedure to synchronize the clock signals of two or more devices.

ACKNOWLEDGE

Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter during the time that master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after receiving each byte. A master receiver must also generate an acknowledge after receiving each byte which is clocked out by the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end-of-data from the transmitter and stop generating an acknowledge on the last byte which has been clocked out by the slave. In this moment, the transmitter must leave the data line HIGH and let the master to generate a STOP condition. Acknowledgement on the I²C Interface is illustrated in Fig.7.


Fig .4 Bit transfer

Fig .5 Definition of START and STOP conditions

Fig .6 System configuration

Fig .7 Acknowledgement on the I^{2}C Interface

I^{2}C Interface protocol

The ST7545T supports command, data write addressed slaves on the bus.

Before any data is transmitted on the I^{2}C Interface, the device, which should respond, is addressed first. Four 7-bit slave addresses (0111**00**,0111**01**, 0111**10** and 0111**11**) are reserved for the ST7545T. The least significant bit of the slave address is set by connecting the input SA0 and SA1 to either logic 0 (or logic 1 (VDD1).

The I^{2}C Interface protocol is illustrated in Fig.8.

The sequence is initiated with a START condition (S) from the I^{2}C Interface master, which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the I^{2}C Interface transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves.

A command word consists of a control byte, which defines Co and A0, plus a data byte.

The last control byte is tagged with a cleared most significant bit (i.e. the continuation bit Co). After a control byte with a cleared Co bit, only data bytes will follow. The state of the A0 bit defines whether the data byte is interpreted as a command or as RAM data. All addressed slaves on the bus also acknowledge the control and data bytes. After the last control byte, depending on the A0 bit setting; either a series of display data bytes or command data bytes may follow. If the A0 bit is set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer. The data pointer is automatically updated and the data is directed to the intended ST7545T device. If the A0 bit of the last control byte is set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands. Only the addressed slave makes the acknowledgement after each byte. At the end of the transmission the I^{2}C INTERFACE-bus master issues a STOP condition (P).If the R/W bit is set to logic 1 the chip will output data immediately after the slave address if the A0 bit, which was sent during the last write access, is set to logic 0. If no acknowledge is generated by the master after a byte, the driver stops transferring data to the master.

Write mode
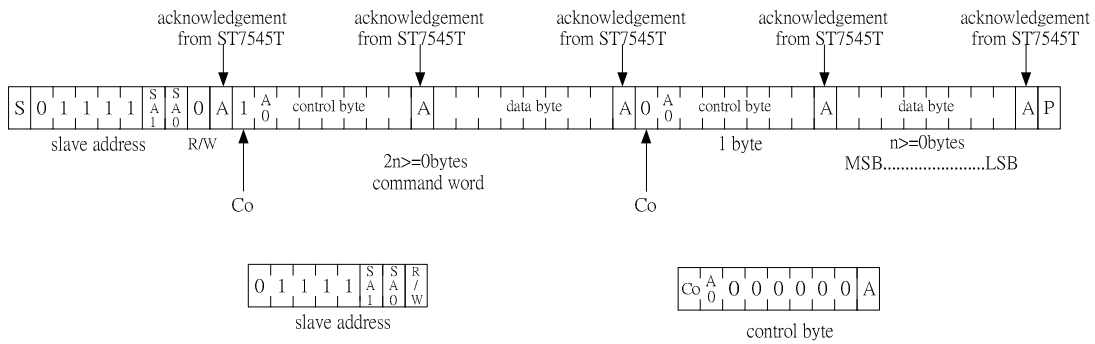
Fig .8   IIC Interface protocol

Co	0	Last control byte to be sent. Only a stream of data bytes is allowed to follow. This stream may only be terminated by s STOP or RE-START condition.
	1	Another control byte will follow the data byte unless a STOP or RE-START condition is received.

Data Transfer

The ST7545T uses bus holder and internal data bus for data transfer with the MPU. When writing data from the MPU to on-chip RAM, data is automatically transferred from the bus holder to the RAM as shown in figure 9. And when reading data from on-chip RAM to the MPU, the data for the initial read cycle is stored in the bus holder (dummy read) and the MPU reads this stored data from bus holder for the next data read cycle as shown in figure 10. This means that a dummy read cycle must be inserted between each pair of address sets when a sequence of address sets is executed. Therefore, the data of the specified address cannot be output with the read display data instruction right after the address sets, but can be output at the second read of data.
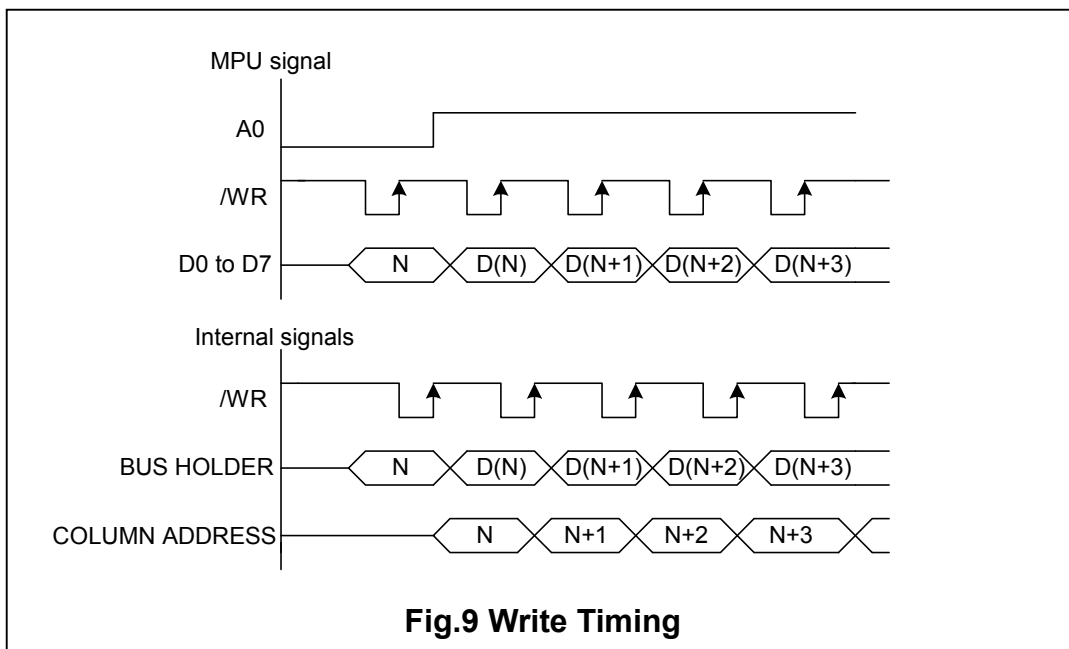
Fig.9 Write Timing

Fig.10 Read Timing
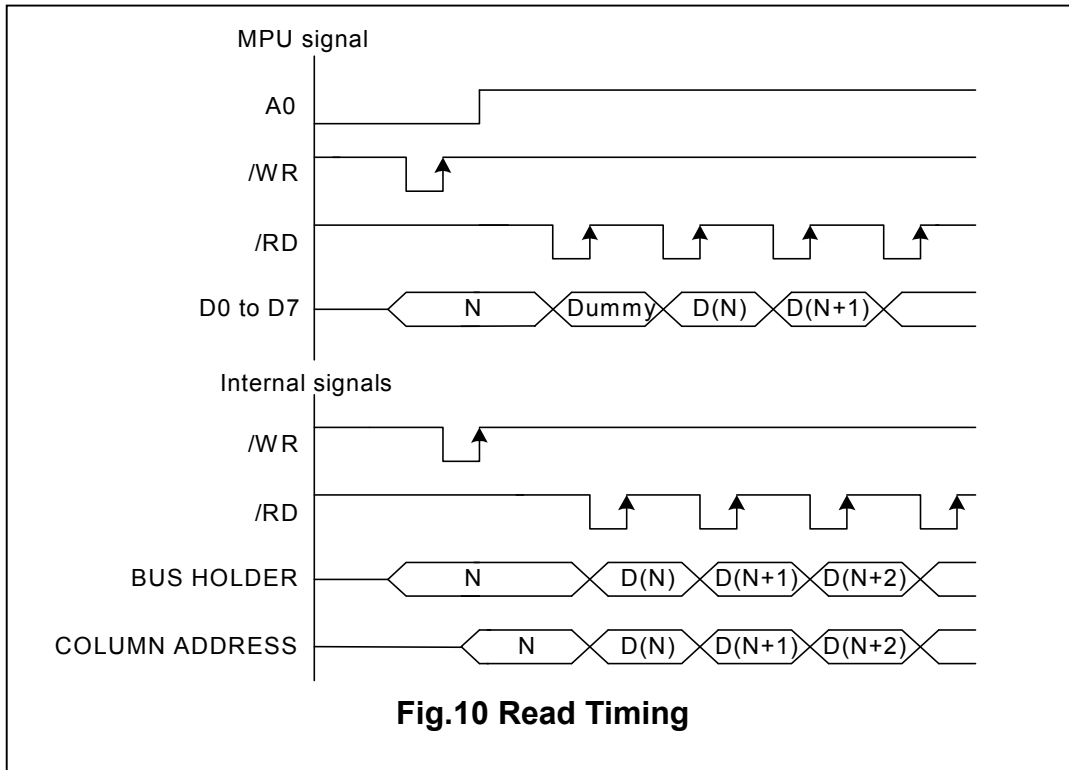
DISPLAY DATA RAM (DDRAM)

The ST7545T contains a 66X102 bit static RAM that stores the display data. The Display Data RAM (DDRAM) stores the dot data for the LCD. The size is 66(8 pageX8 bit +1 pageX1 bit +1 pageX1 bit) X 102 bits. The mapping is directly corresponded to the X-address and column output number. It is 66-row by 102-column addressable array. Each pixel can be selected when the page and column addresses are specified. The 65 rows are divided into: 8 pages (Page0~7) (COM[0..63]) use full data bits (D7~D0), 8th page (Page8) with single line (COM[64]) uses only one data bit (D0) and 9th page (Page9) with a single line of ICON (COMS) uses only one data bit (D0).

Data is read from or written to the DDRAM directly through D0 to D7. The display data (D0 to D7) comes from the corresponded pins of microprocessor. The microprocessor can read from and write to the DDRAM through the I/O port. Since the LCD controller operates independently, data can be written into DDRAM at the same time as data being displayed without causing the LCD flicker.

Page Address Circuit

This circuit is for providing a Page Address to Display Data RAM. It incorporates 4-bit Page Address register changed by only the "Set Page" instruction. Page Address 9 is a special RAM area for the icons and display data D0 is only valid.

Line Address Circuit

This circuit assigns DDRAM a Line Address corresponding to the first line (COM0) of the display. Therefore, by setting Line Address repeatedly, it is possible to realize the screen scrolling and page switching without changing the contents of on-chip RAM as shown in figure 10. It incorporates 7-bit Line Address register changed by only the initial display line instruction and 7-bit counter circuit. At the beginning of each LCD frame, the contents of register are copied to the line counter which is increased by CL signal and generates the line address for transferring the 102-bit RAM data to the display data latch circuit. When icon is selected by setting icon page address, display data of icons are not scrolled because the MPU cannot access Line Address of icons.

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Column Address Circuit

Column Address Circuit has an 8-bit preset counter that provides Column Address to the Display Data RAM. The display data RAM column address is specified by the Column Address Set command. The specified column address is incremented (+1) with each display data read/write command. This allows the MPU display data to be accessed continuously.

ADDRESSING

Data is downloaded in bytes into the RAM matrix of ST7545T. The display RAM has a matrix of 66 by 102 bits. The address pointer addresses the columns. The address ranges are: X 0 to 101 (1100101),Y 0 to 9 (1001) .Addresses outside these ranges are not allowed.In vertical addressing mode (V=1) the Y address increments after each byte. After the last Y address (Y = 8), Y wraps around to 0 and X increments to address the next column.In horizontal addressing mode (V=0) the X address increments after each byte. After the last X address(X = 101) X wraps around to 0 and Y increments to address the next row.After the very last address (X = 101, Y = 8) the address pointers wrap around to address (X = 0, Y =0)

Data structure

RAM format, addressing

Sequence of writing data bytes into RAM with vertical addressing (V=1)

Sequence of writing data bytes into RAM with horizontal addressing (V=0)

Page Address				Data		Line Address	When the common output is normal	COM Output
D3	D2	D1	D0					
0	0	0	0	D0–D7	Page 0	00H–07H		COM0–COM7
0	0	0	1	D0–D7	Page 1	08H–0FH		COM8–COM15
0	0	1	0	D0–D7	Page 2	10H–17H		COM16–COM23
0	0	1	1	D0–D7	Page 3	18H–1FH		COM24–COM31
0	1	0	0	D0–D7	Page 4	20H–27H		COM32–COM39
0	1	0	1	D0–D7	Page 5	28H–2FH		COM40–COM47
0	1	1	0	D0–D7	Page 6	30H–37H		COM48–COM55
0	1	1	1	D0–D7	Page 7	38H–3FH		COM56–COM63
1	0	0	0	D0	Page 8	40H		COM64
1	0	0	1	D0	Page 9	41H		ICON (COMS)

65 lines

Start

Column address: 00, 01, 02, 03, 04, 05, 06, 07, 08 ... 5D, 5E, 5F, 60, 61, 62, 63, 64, 65, 0, D0, MX

LCD Out: S0, S1, S2, S3, S4, S5, S6, S7, S8 ... S93, S94, S95, S96, S97, S98, S99, S100, S101

Regardless of the display start line address,
1/66duty => 65th line

Display Data RAM Map (66 COM)

ST7545T

Oscillator

The on-chip oscillator provides the clock signal for the display system. No external components are required and the OSC input must be connected to VDD. An external clock signal, if used, is connected to this input.

LCD DRIVER CIRCUIT

66-channel common drivers and 102-channel segment drivers configure this driver circuit. This LCD panel driver voltage depends on the combination of display data and M signal.

Typical LCD driver waveforms
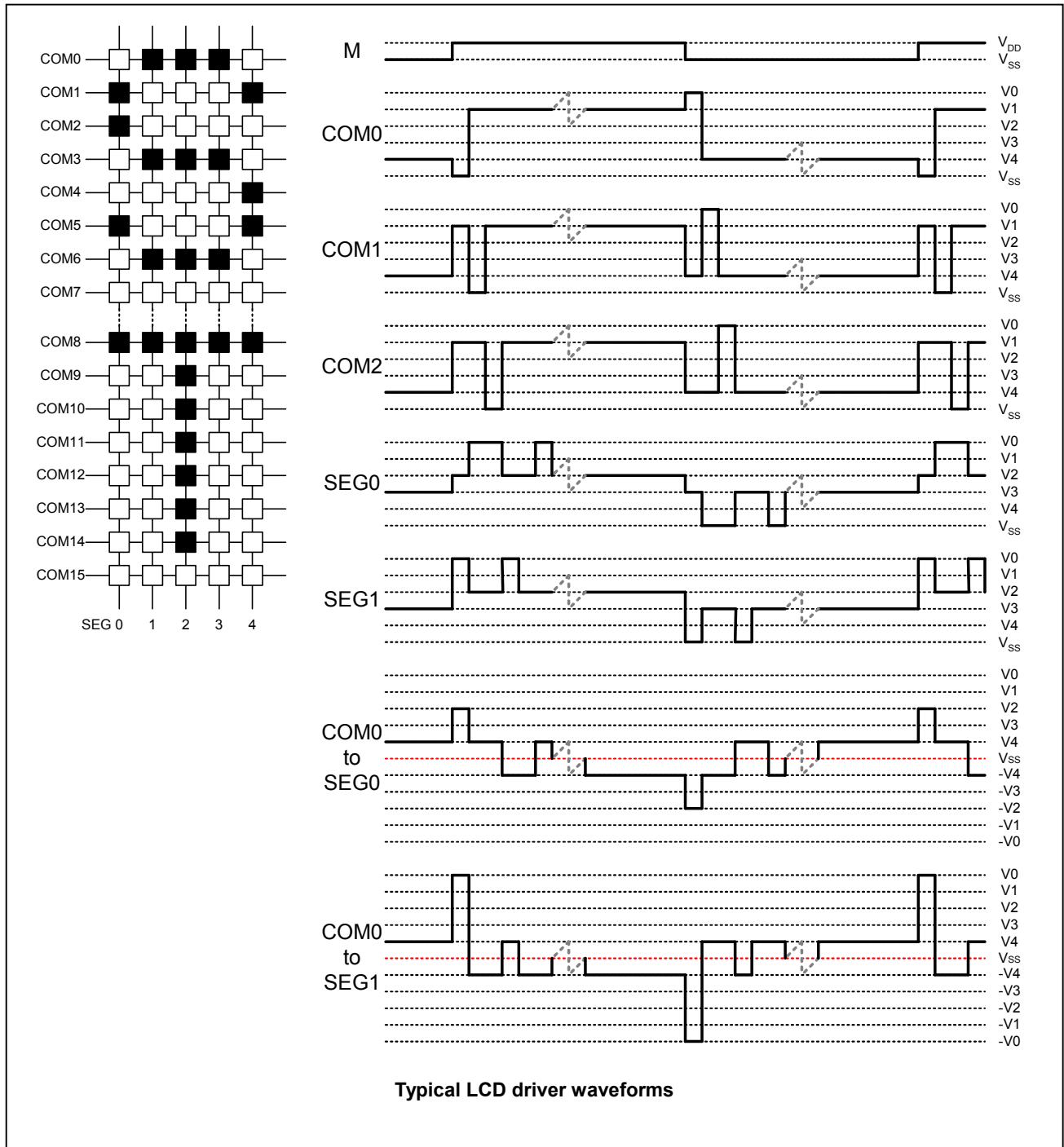
7. RESET CIRCUIT

Setting RESB to "L" or Reset instruction can initialize internal function.

When RESB becomes "L", following procedure is occurred.

Page address: 0

Column address: 0

Display control: Display blank

Oscillator: OFF

Power down mode (PD = 1)

Horizontal addressing (V = 0)

Normal instruction set (H = 0)

Display blank (E = D = 0)

Address counter X [6:0] = 0, Y [3:0] = 0

Bias system (BS [2:0] = BR setting)

V_{OP} is equal to 0; the HV generator is switched off (V_{OP}[6:0] = 0)

After power-on, RAM data are undefined

While RESB is "L" or reset instruction is executed, no instruction except read status can be accepted. Reset status appears at DB0. After DB0 becomes "L", any instruction can be accepted. RESB must be connected to the reset pin of the MPU, and initialize the MPU and this LSI at the same time. The initialization by RESB is essential before used.

8. INSTRUCTION TABLE

INSTRUCTION	A0	WR (R/W)	COMMAND BYTE								DESCRIPTION
			D7	D6	D5	D4	D3	D2	D1	D0	
H=0 or 1											
NOP	0	0	0	0	0	0	0	0	0	0	No operation
Function set	0	0	0	0	1	0	0	PD	V	H	Power-down; entry mode;
Write data	1	0	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0	Write data to RAM

INSTRUCTION	A0	WR (R/W)	COMMAND BYTE								DESCRIPTION
			D7	D6	D5	D4	D3	D2	D1	D0	
H=0											
Display control	0	0	0	0	0	0	1	D	0	E	Sets display configuration
Set Y address of RAM	0	0	0	1	0	0	Y_3	Y_2	Y_1	Y_0	Sets Y address of RAM $0 \leq Y \leq 9$
Set X address of RAM	0	0	1	X_6	X_5	X_4	X_3	X_2	X_1	X_0	Sets X address of RAM $0 \leq X \leq 101$
H=1											
Reserved	0	0	0	0	0	0	0	0	1	X	Do not use
Bias system	0	0	0	0	0	1	0	BS_2	BS_1	BS_0	Sets bias system (BSx)
Reserved	0	0	0	1	X	X	X	X	X	X	Do not use(reserved for test)
Set V0 (V_{OP}) voltage	0	0	1	V_{OP6}	V_{OP5}	V_{OP4}	V_{OP3}	V_{OP2}	V_{OP1}	V_{OP0}	Set V0 (V_{OP}) output voltage

9. INSTRUCTION DESCRIPTION

H="0" or "1"

Function Set

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	1	0	0	PD	V	H

Flag	Description
PD	All LCD outputs are fixed at VSS (display off), internal power circuits are turned off, V_{OUT} can be disconnected, oscillator is off (external clock possible), RAM contents not cleared; RAM data can be written. PD=0:chip is active PD=1:chip is in power down mode
V	When V = 0, the horizontal addressing mode is selected. When V = 1, the vertical addressing mode is selected.
H	When H = 0 the commands 'display control', 'set Y address' and 'set X address' can be performed. When H = 1 the others can be executed. The commands 'write data' and 'function set' can be executed in both cases.

Write data

8-bit data of Display Data from the microprocessor can be written to the RAM location specified by the column address and page address. The column address is increased by 1 automatically so that the microprocessor can continuously write data to the addressed page. During auto-increment, the column address wraps to 0 after the last column is written.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
1	0	Write data

H="0"

Display Control

This bits D and E selects the display mode.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	0	1	D	0	E

Flag	Description		
D,E	D	E	The bits D and E select the display mode.
	0	0	Display blank
	1	0	Normal display
	0	1	All display segments on
	1	1	Inverse video mode

ST7545T

Set Y address of RAM

Y [3:0] defines the Y address vector address of the display RAM.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	1	0	0	Y_3	Y_2	Y_1	Y_0

Y_3	Y_2	Y_1	Y_0	CONTENT	ALLOWED X-RANGE
0	0	0	0	Page0 (display RAM)	0 to 101
0	0	0	1	Page1 (display RAM)	0 to 101
0	0	1	0	Page2 (display RAM)	0 to 101
0	0	1	1	Page3 (display RAM)	0 to 101
0	1	0	0	Page4 (display RAM)	0 to 101
0	1	0	1	Page5 (display RAM)	0 to 101
0	1	1	0	Page6 (display RAM)	0 to 101
0	1	1	1	Page7 (display RAM)	0 to 101
1	0	0	0	Page8 (display RAM)	0 to 101
1	0	0	1	Page9 (display RAM)	0 to 101

Set X address of RAM

The X address points to the columns. The range of X is 0…101.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	1	X_6	X_5	X_4	X_3	X_2	X_1	X_0

X_6	X_5	X_4	X_3	X_2	X_1	X_0	Column address
0	0	0	0	0	0	0	0
0	0	0	0	0	0	1	1
0	0	0	0	0	1	0	2
0	0	0	0	0	1	1	3
:	:	:	:	:	:	:	:
1	1	0	0	0	1	0	98
1	1	0	0	0	1	1	99
1	1	0	0	1	0	0	100
1	1	0	0	1	0	1	101

H="1"

System Bias

Select LCD bias ratio of the voltage required for driving the LCD.

A0	WR(R/W)	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	0	1	0	BS_2	BS_1	BS_0

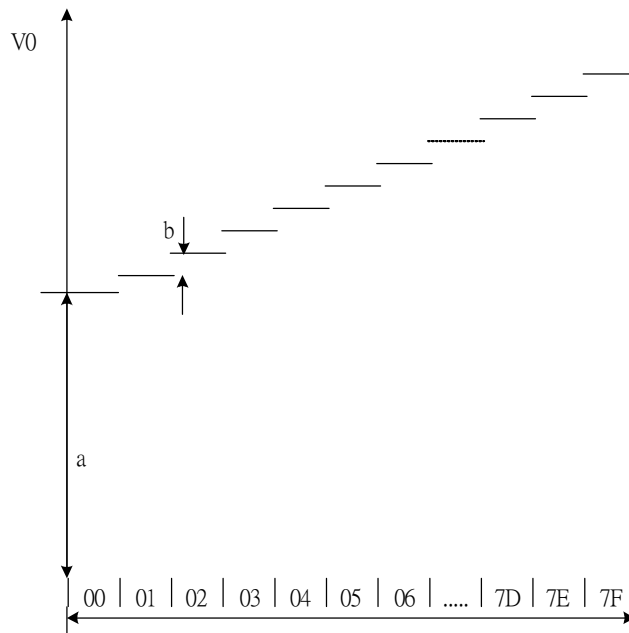| BS_2	BS_1	BS_0	Bias	Recommend Duty
0	0	0	11	1:100
0	0	1	10	1:81
0	1	0	9	1:65/1:68
0	1	1	8	1:49
1	0	0	7	1/40:1/36
1	0	1	6	1/24
1	1	0	5	1:18/1:16
1	1	1	4	1:10/1:9/1:8

Set V0 (V$_{OP}$) voltage:

The operation voltage V0 (V$_{OP}$) can be set by software.

$$V_0 = (a + V_{OP} \times b)$$ (1)

Typical values for parameter for the HV-Generator programming

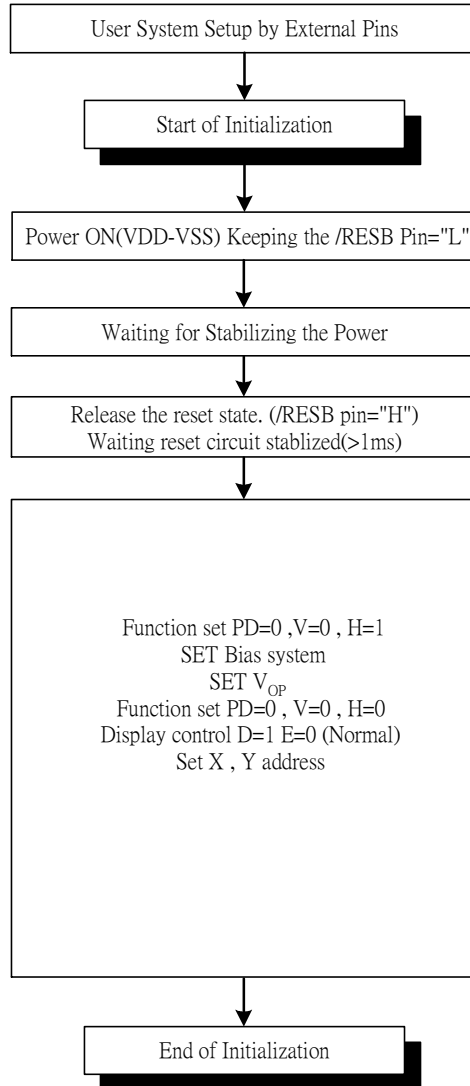| SYMBOL	VALUE	UNIT
a	6.75	V
b	0.03	V

V$_{OP}$[6:0](programmed) {00 hex… 7F hex}

Fig 13. V$_{OP}$ programming of ST7545T

10. COMMAND DESCRIPTION

Referential Instruction Setup Flow: Initializing with the built-in Power Supply Circuits

```
┌─────────────────────────────────────────┐
│     User System Setup by External Pins   │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│          Start of Initialization         │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│  Power ON(VDD-VSS) Keeping the /RESB Pin="L" │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│       Waiting for Stabilizing the Power  │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│  Release the reset state. (/RESB pin="H")│
│  Waiting reset circuit stablized(>1ms)   │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│                                          │
│      Function set PD=0 ,V=0 , H=1         │
│            SET Bias system                │
│              SET V_OP                     │
│      Function set PD=0 , V=0 , H=0        │
│     Display control D=1 E=0 (Normal)      │
│            Set X , Y address              │
│                                          │
└─────────────────────────────────────────┘
                    │
┌─────────────────────────────────────────┐
│           End of Initialization          │
└─────────────────────────────────────────┘
```

Initializing with the Built-in Power Supply Circuits

11. LIMITING VALUES

In accordance with the Absolute Maximum Rating System; see notes 1 and 2.

Parameter	Symbol	Conditions	Unit
Power Supply Voltage	VDD1	-0.5 ~ 5	V
Power supply voltage	VDD2	-0.5 ~ 5	V
Power supply voltage (VDD standard)	V0, V_{OUT}	-0.3~13.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	0.3 to V_{OUTIN}	V
Operating temperature	TOPR	–30 to +85	°C
Storage temperature	TSTR	–65 to +150	°C

System (MPU) side   ST7545T chip side
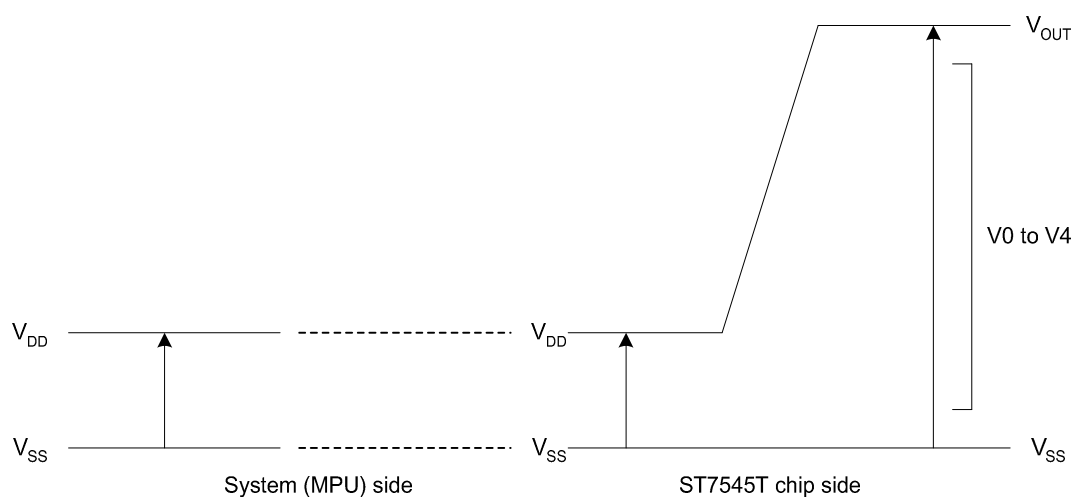
Notes

1. Stresses above those listed under Limiting Values may cause permanent damage to the device.

2. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

3. Insure that the voltage levels of V0, V1, V2, V3 and V4 are always such that:

$V_{OUTIN} \geq V0 \geq V1 \geq V2 \geq V3 \geq V4 \geq Vss$

ST7545T

12. HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take normal precautions appropriate to handling MOS devices (see "Handling MOS devices").

13. DC CHARACTERISTICS

V_{DD1} = 1.7 V to 3.3V; V_{SS} = 0 V; T_{amb} = -30℃ to +85℃; **unless otherwise specified**.

Item	Symbol	Condition		Rating			Units	Applicable Pin
				Min.	Typ.	Max.		
Operating Voltage (1)	VDD1			1.7	—	3.3	V	Vss
Operating Voltage (2)	VDD2	(Relative to VSS)		2.4	—	3.3	V	VSS
High-level Input Voltage	VIHC			0.7 x VDD	—	VDD	V	
Low-level Input Voltage	VILC			VSS	—	0.3 x VDD	V	
High-level Output Voltage	VOHC			0.7 x VDD	—	VDD	V	
Low-level Output Voltage	VOLC			VSS	—	0.3 x VDD	V	
Input leakage current	ILI			–1.0	—	1.0	μA	
Output leakage current	ILO			–3.0	—	3.0	μA	
Liquid Crystal Driver ON Resistance	RON	Ta = 25°C (Relative To VSS)	V_{OUTIN} = 13.0 V	—	2.0	3.5	KΩ	SEGn COMn *6
			V_{OUTIN} = 8.0 V	—	3.2	5.4		
Frame frequency	FR			65.7	73	80.4	Hz	

	Item	Symbol	Condition	Rating			Units	Applicable Pin
				Min.	Typ.	Max.		
Internal Power	Input Voltage	VDD1	(Relative To VSS)	1.7	—	3.3	V	
	Voltage Booster Output Voltage	V_{OUTOUT}	(Relative To VSS)	—	—	13.5	V	V_{OUTOUT}
	Voltage Regulator Operating Voltage	V_{OUTIN}	(Relative To VSS)	—	—	13.5	V	V_{OUTIN}

ST7545T

Dynamic Consumption Current: During Display, with the Internal Power Supply OFF Current consumed by total ICs (bare die)

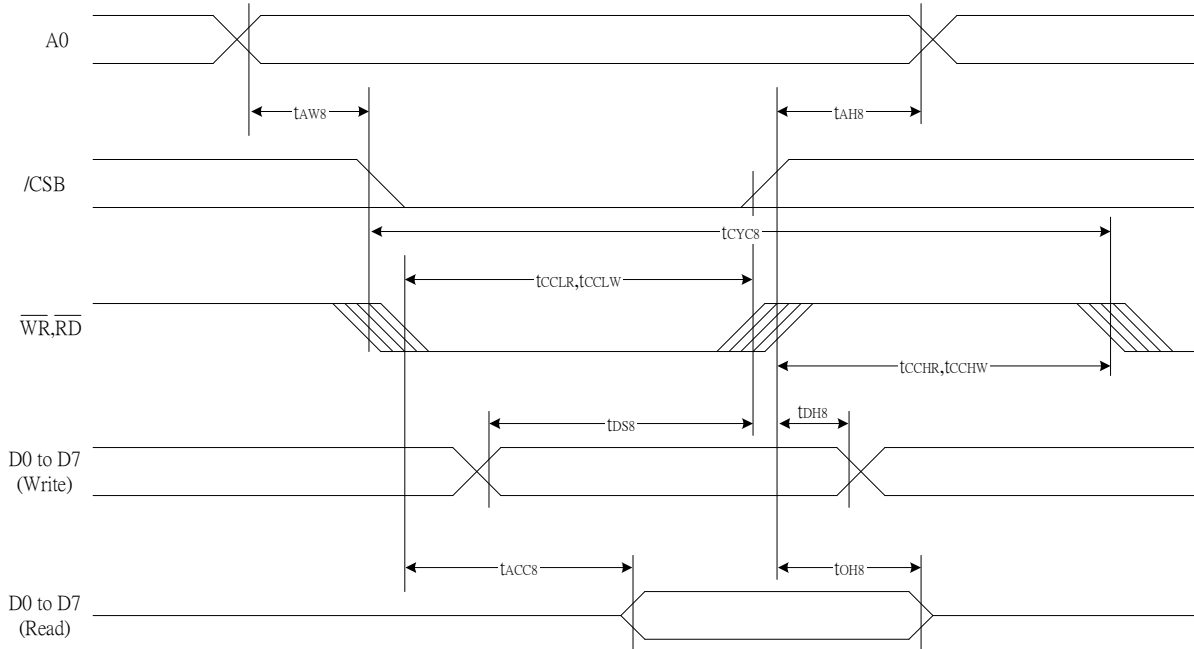| Test pattern	Symbol	Condition	Rating			Units	Notes
			Min.	Typ.	Max.		
Display Pattern SNOW	ISS	VDD = 3.0 V, Booster X4 V0 – VSS = 9.0 V	—	300	—	μA	
Power Down	ISS	Ta = 25°C	—	0.01	2	μA	

Notes to the DC characteristics

1. The maximum possible V_{OUT} voltage that may be generated is dependent on voltage, temperature and (display) load.

2. Internal clock

3. Power-down mode. During power down all static currents are switched off.

4. If external V_{OUTIN}, the display load current is not transmitted to I_{DD}.

5. V_{OUT} external voltage applied to V_{OUTIN} pin; V_{OUTIN} disconnected from V_{OUTOUT} (no connect)

14. TIMING CHARACTERISTICS

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)

Figure 26.

(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating Min.	Rating Max.	Units
Address hold time	A0	tAH8		10	—	ns
Address setup time		tAW8		100	—	
System cycle time		tCYC8		400	—	
Enable L pulse width (WRITE)	WR	tCCLW		80	—	
Enable H pulse width (WRITE)		tCCHW		80	—	
Enable L pulse width (READ)	RD	tCCLR		140	—	
Enable H pulse width (READ)		tCCHR		80		
WRITE Data setup time	D0 to D7	tDS8		80	—	
WRITE Address hold time		tDH8		10	—	
READ access time		tACC8	CL = 100 pF	—	70	
READ Output disable time		tOH8	CL = 100 pF	5	50	

(VDD = 2.7V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH8		15	—	ns
Address setup time		tAW8		150	—	
System cycle time		tCYC8		600	—	
Enable L pulse width (WRITE)	WR	tCCLW		220	—	
Enable H pulse width (WRITE)		tCCHW		180	—	
Enable L pulse width (READ)	RD	tCCLR		220	—	
Enable H pulse width (READ)		tCCHR		180	—	
WRITE Data setup time	D0 to D7	tDS8		120	—	
WRITE Address hold time		tDH8		15	—	
READ access time		tACC8	CL = 100 pF	—	140	
READ Output disable time		tOH8	CL = 100 pF	10	100	

(VDD = 1.8V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH8		30	—	ns
Address setup time		tAW8		200	—	
System cycle time		tCYC8		1000	—	
Enable L pulse width (WRITE)	WR	tCCLW		360	—	
Enable H pulse width (WRITE)		tCCHW		280	—	
Enable L pulse width (READ)	RD	tCCLR		360	—	
Enable H pulse width (READ)		tCCHR		280		
WRITE Data setup time	D0 to D7	tDS8		200	—	
WRITE Address hold time		tDH8		30	—	
READ access time		tACC8	CL = 100 pF	—	240	
READ Output disable time		tOH8	CL = 100 pF	10	200	

*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,

(tr +tf) $\leqq$ (tCYC8 – tCCLW – tCCHW) for (tr + tf) $\leqq$ (tCYC8 – tCCLR – tCCHR) are specified.

*2 All timing is specified using 20% and 80% of VDD as the reference.

*3 tCCLW and tCCLR are specified as the overlap between CSB being "L" and WR and RD being at the "L" level.

ST7545T

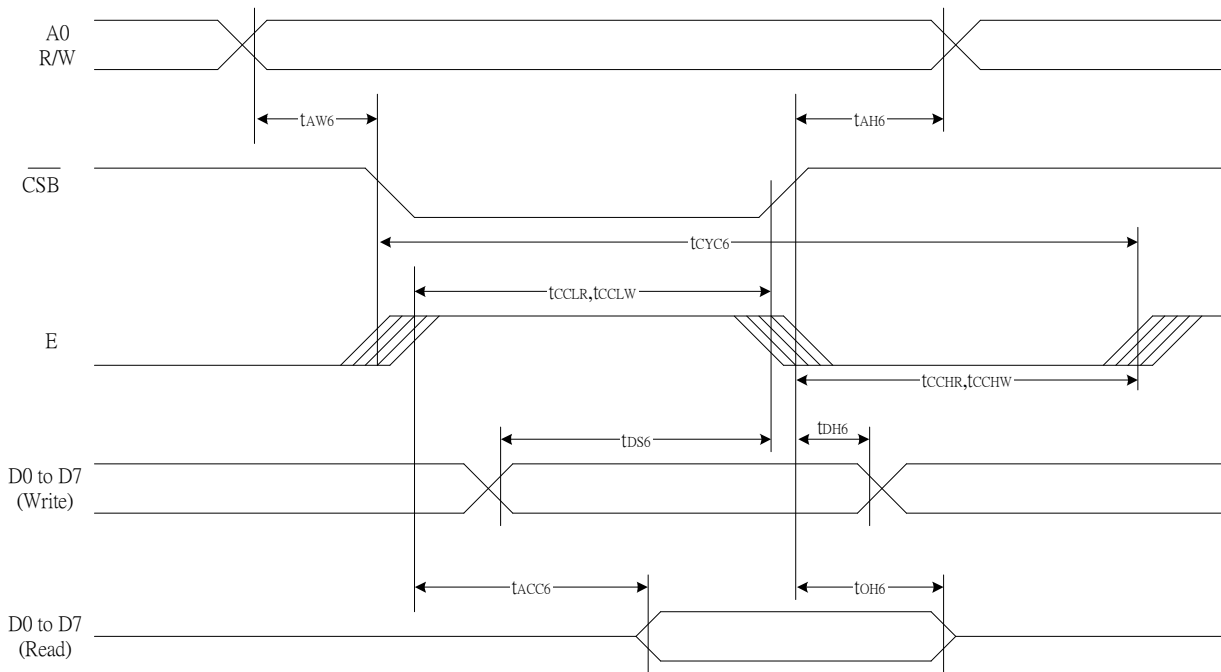**System Bus Read/Write Characteristics 1 (For the 6800 Series MPU)**

Figure 27.

(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	**Max.**	
Address hold time	A0	tAH6		10	—	ns
Address setup time		tAW6		0	—	
System cycle time		tCYC6		240	—	
Enable L pulse width (WRITE)	WR	tEWLW		80	—	
Enable H pulse width (WRITE)		tEWHW		80	—	
Enable L pulse width (READ)	RD	tEWLR		80	—	
Enable H pulse width (READ)		tEWHR		140		
WRITE Data setup time	D0 to D7	tDS6		80	—	
WRITE Address hold time		tDH6		10	—	
READ access time		tACC6	CL = 100 pF	—	70	
READ Output disable time		tOH6	CL = 100 pF	5	50	

(VDD = 2.7V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH6		15	—	ns
Address setup time		tAW6		0	—	
System cycle time		tCYC6		400	—	
Enable L pulse width (WRITE)	WR	tEWLW		220	—	
Enable H pulse width (WRITE)		tEWHW		180	—	
Enable L pulse width (READ)	RD	tEWLR		220	—	
Enable H pulse width (READ)		tEWHR		180	—	
WRITE Data setup time	D0 to D7	tDS6		120	—	
WRITE Address hold time		tDH6		15	—	
READ access time		tACC6	CL = 100 pF	—	140	
READ Output disable time		tOH6	CL = 100 pF	10	100	

(VDD = 1.8V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0	tAH6		30	—	ns
Address setup time		tAW6		0	—	
System cycle time		tCYC6		640	—	
Enable L pulse width (WRITE)	WR	tEWLW		360	—	
Enable H pulse width (WRITE)		tEWHW		280	—	
Enable L pulse width (READ)	RD	tEWLR		360	—	
Enable H pulse width (READ)		tEWHR		280	—	
WRITE Data setup time	D0 to D7	tDS6		200	—	
WRITE Address hold time		tDH6		30	—	
READ access time		tACC6	CL = 100 pF	—	240	
READ Output disable time		tOH6	CL = 100 pF	10	200	

*1 The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,

(tr +tf) $\leq$ (tCYC6 – tEWLW – tEWHW) for (tr + tf) $\leq$ (tCYC6 – tEWLR – tEWHR) are specified.

*2 All timing is specified using 20% and 80% of VDD as the reference.

*3 tEWLW and tEWLR are specified as the overlap between CSB being "L" and E.
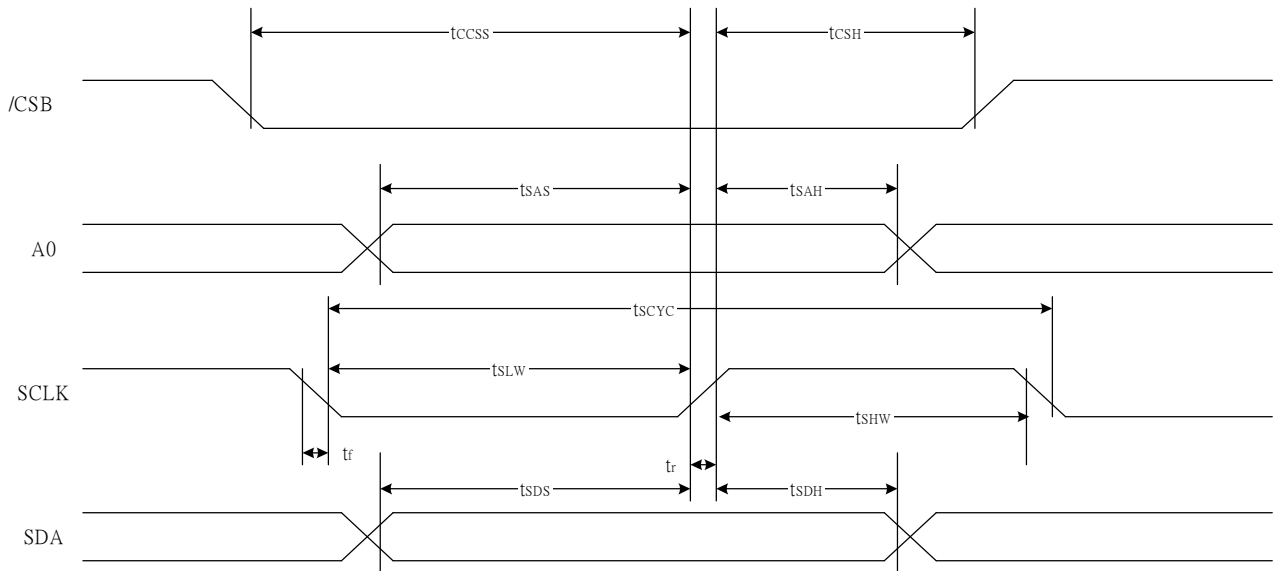
SERIAL INTERFACE(4-Line Interface)

Fig 28.

(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period		tSCYC		150	—	
SCL "H" pulse width	SCL	tSHW		75	—	
SCL "L" pulse width		tSLW		75	—	
Address setup time	A0	tSAS		20	—	
Address hold time		tSAH		100	—	ns
Data setup time	SI	tSDS		20	—	
Data hold time		tSDH		10	—	
CS-SCL time	CSB	tCSS		20	—	
CS-SCL time		tCSH		140	—	

(VDD = 2.7V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period		tSCYC		300	—	
SCL "H" pulse width	SCL	tSHW		150	—	
SCL "L" pulse width		tSLW		150	—	
Address setup time	A0	tSAS		30	—	
Address hold time		tSAH		150	—	ns
Data setup time	SI	tSDS		30	—	
Data hold time		tSDH		20	—	
CS-SCL time	CSB	tCSS		30	—	
CS-SCL time		tCSH		200	—	

(VDD = 1.8V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period	SCL	tSCYC		500	—	ns
SCL "H" pulse width		tSHW		250	—	
SCL "L" pulse width		tSLW		250	—	
Address setup time	A0	tSAS		60	—	
Address hold time		tSAH		250	—	
Data setup time	SI	tSDS		60	—	
Data hold time		tSDH		50	—	
CS-SCL time	CSB	tCSS		40	—	
CS-SCL time		tCSH		350	—	

*1 The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

*2 All timing is specified using 20% and 80% of VDD as the standard.

SERIAL INTERFACE(3-Line Interface)
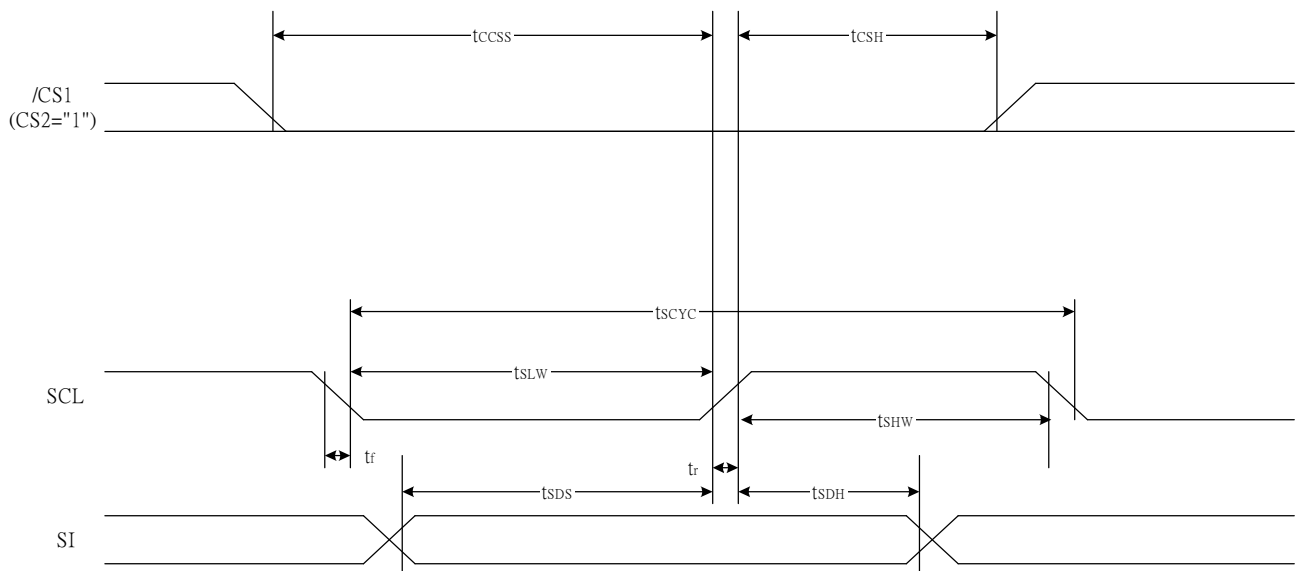
Fig 28.

(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating Min.	Rating Max.	Units
Serial Clock Period	SCL	tSCYC		150	—	ns
SCL "H" pulse width	SCL	tSHW		75	—	ns
SCL "L" pulse width	SCL	tSLW		75	—	ns
Data setup time	SI	tSDS		20	—	ns
Data hold time	SI	tSDH		10	—	ns
CS-SCL time	CSB	tCSS		20	—	ns
CS-SCL time	CSB	tCSH		140	—	ns

(VDD = 2.7V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating Min.	Rating Max.	Units
Serial Clock Period	SCL	tSCYC		300	—	ns
SCL "H" pulse width	SCL	tSHW		150	—	ns
SCL "L" pulse width	SCL	tSLW		150	—	ns
Data setup time	SI	tSDS		30	—	ns
Data hold time	SI	tSDH		20	—	ns
CS-SCL time	CSB	tCSS		30	—	ns
CS-SCL time	CSB	tCSH		200	—	ns

(VDD = 1.8V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period	SCL	tSCYC		500	—	ns
SCL "H" pulse width		tSHW		250	—	
SCL "L" pulse width		tSLW		250	—	
Data setup time	SI	tSDS		60	—	
Data hold time		tSDH		50	—	
CS-SCL time	CSB	tCSS		40	—	
CS-SCL time		tCSH		350	—	

*1 The input signal rise and fall time (tr, tf) are specified at 15 ns or less.

*2 All timing is specified using 20% and 80% of VDD as the standard.

SERIAL INTERFACE(I^{2}C Interface)
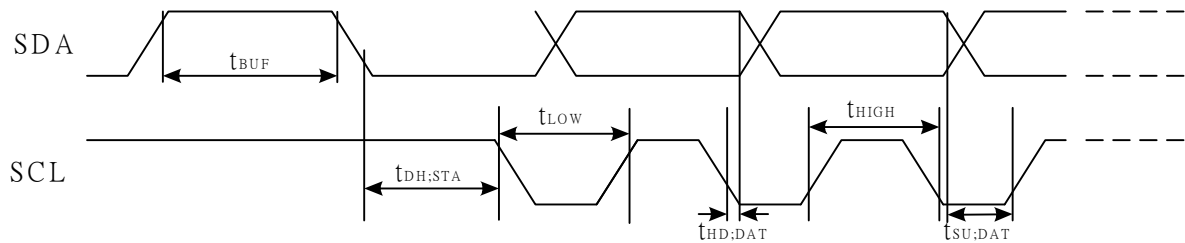
(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
SCL clock frequency	SCL	FSCLK		-	400	kHZ
SCL clock low period	SCL	TLOW		1.3	-	us
SCL clock high period	SCL	THIGH		0.6	-	us
Data set-up time	SI	TSU;Data		100	-	ns
Data hold time	SI	THD;Data		0	0.9	us
SCL,SDA rise time	SCL	TR		20+0.1Cb	300	ns
SCL,SDA fall time	SCL	TF		20+0.1Cb	300	ns
Capacitive load represented by each bus line		Cb		-	400	pF
Setup time for a repeated START condition	SI	TSU;SUA		0.6	-	us
Start condition hold time	SI	THD;STA		0.6	-	us
Setup time for STOP condition		TSU;STO		0.6	-	us
Tolerable spike width on bus		TSW		-	50	ns
BUS free time between a STOP and START condition	SCL	TBUF		1.3		us

15. RESET TIMING
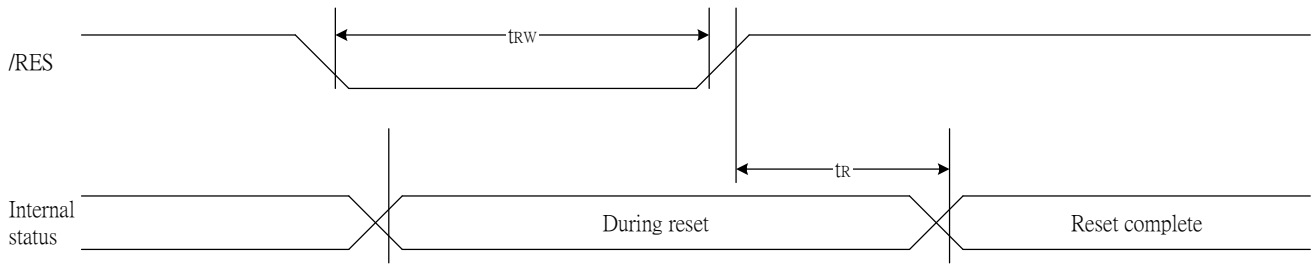
Fig 29.

(VDD = 3.3V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	1	us
Reset "L" pulse width	RESB	tRW		1	—	—	us

(VDD = 2.7V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	2.0	us
Reset "L" pulse width	RESB	tRW		2.0	—	—	us

(VDD = 1.8V , Ta = -30~85°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	**Typ.**	**Max.**	
Reset time		tR		—	—	3.0	us
Reset "L" pulse width	RESB	tRW		3.0	—	—	us

APPICATION NOTE

ST7545T (TMY=0)

Resolution : 66(65COM+ICON)*102(SEG)
Interface : 6800 series
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0 uF

OSC : Vdd
T6 : Vss
T7 : Vdd
T8 : Vdd
T9 : Vdd
PS0 : Vss
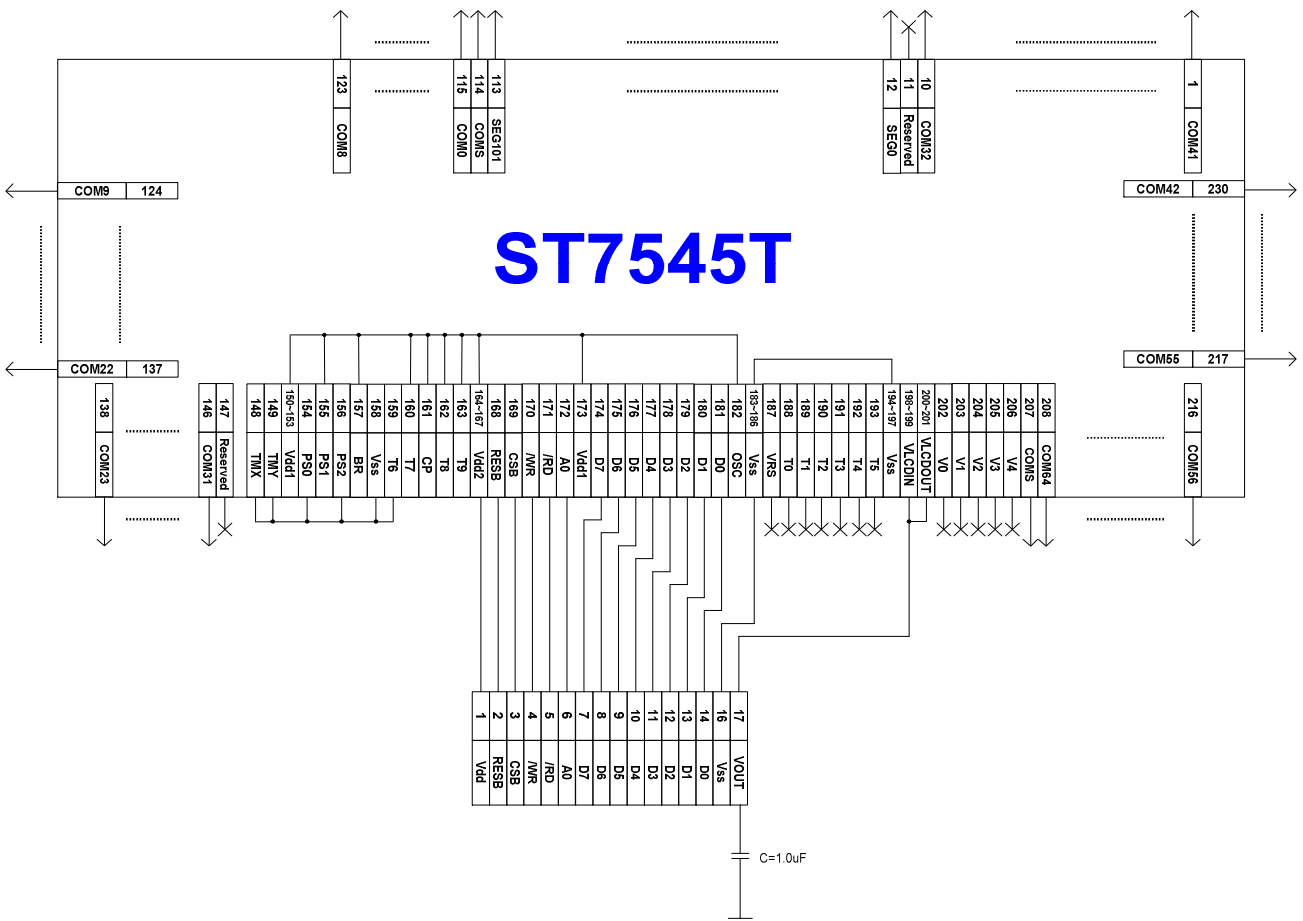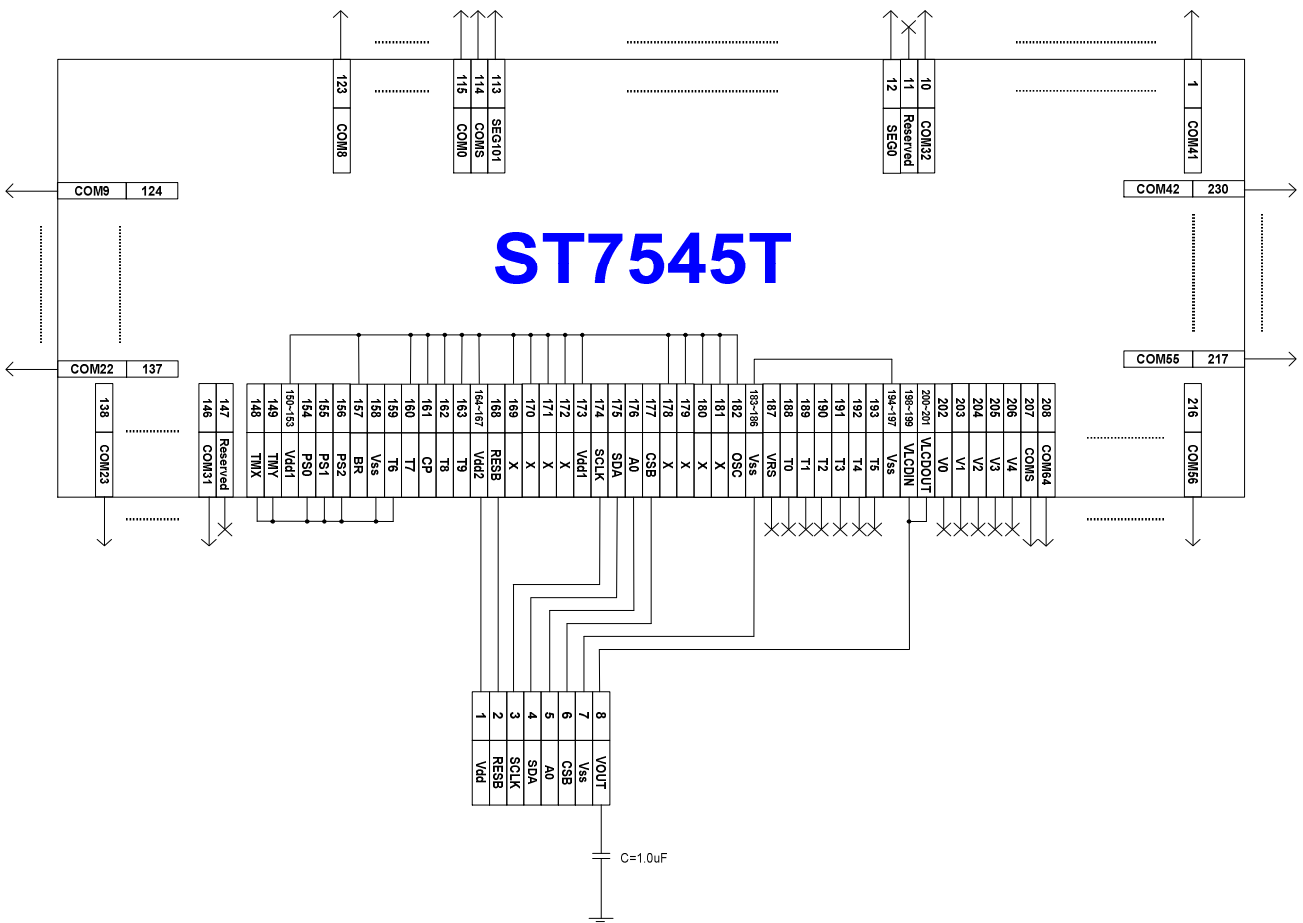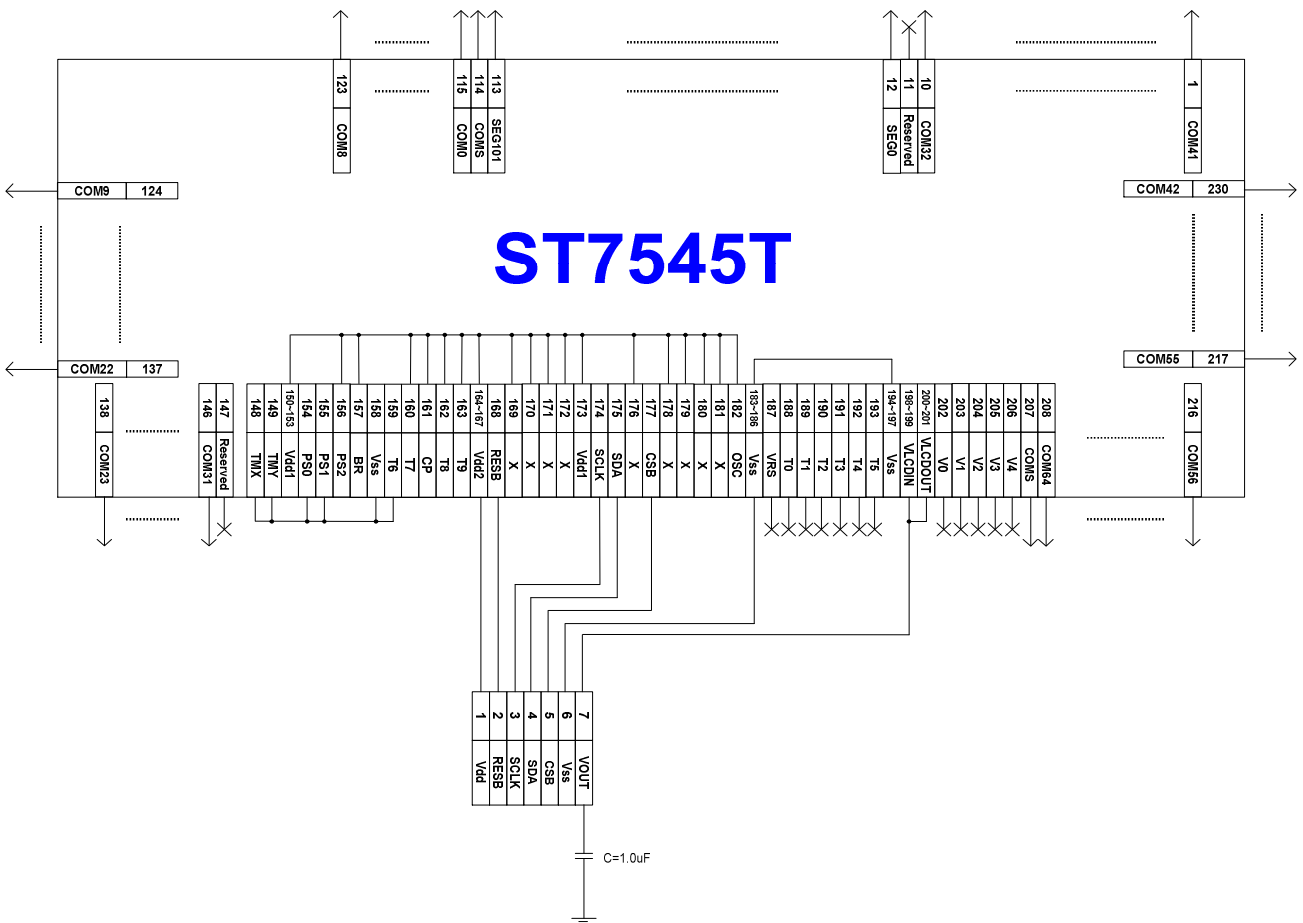PS1 : Vdd
PS2 : Vdd
CP : Vdd
BR : Vdd
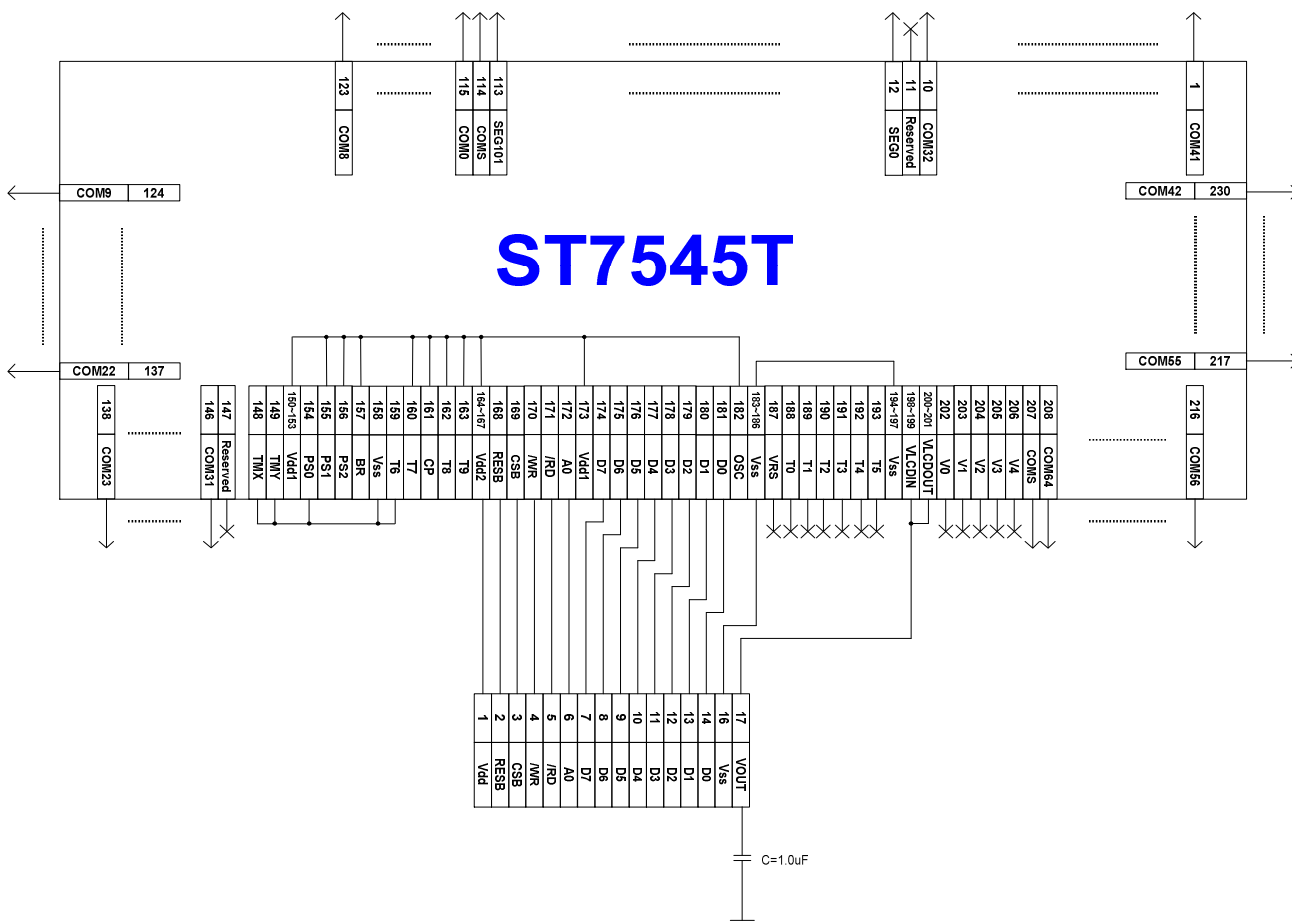
ST7545T (TMY=0)

Resolution : 66(65COM+ICON)*102(SEG)
Interface : 8080 series
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0 uF

OSC : Vdd
T6 : Vss
T7 : Vdd
T8 : Vdd
T9 : Vdd
PS0 : Vss
PS1 : Vdd
PS2 : Vss
CP : Vdd
BR : Vdd

ST7545T (MY=0)

Resolution : 66(65COM+ICON)*102(SEG)
Interface : 4-Line
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0 uF

OSC : Vdd
T6 : Vss
T7 : Vdd
T8 : Vdd
T9 : Vdd
PS0 : Vss
PS1 : Vss
PS2 : Vss
CP : Vdd
BR : Vdd

ST7545T (MY=0)

Resolution : 66(65COM+ICON)*102(SEG)
Interface : 3-Line
Internal analog circuit
Internal OSC
Booster : X5
Bias ratio default : 1/9
(bias ratio can be changed by instruction)
C=1.0 uF

OSC : Vdd
T6 : Vss
T7 : Vdd
T8 : Vdd
T9 : Vdd
PS0 : Vss
PS1 : Vss
PS2 : Vdd
CP : Vdd
BR : Vdd

ST7545T(MY=0)

Resolution : 66(65COM+ICON)*102(SEG) OSC : Vdd
Interface : I2C   T6 : Vss
Internal analog circuit   T7 : Vdd
Internal OSC   T8 : Vdd
Booster : X5   T9 : Vdd
Bias ratio default : 1/9   PS0 : Vdd
(bias ratio can be changed by instruction) PS1 : Vdd
SA[1:0]:(0,0)   PS2 : Vdd
(SA[1:0] are slave address of I2C)   CP : Vdd
C=1.0 uF ; R=10K ohm   BR : Vdd
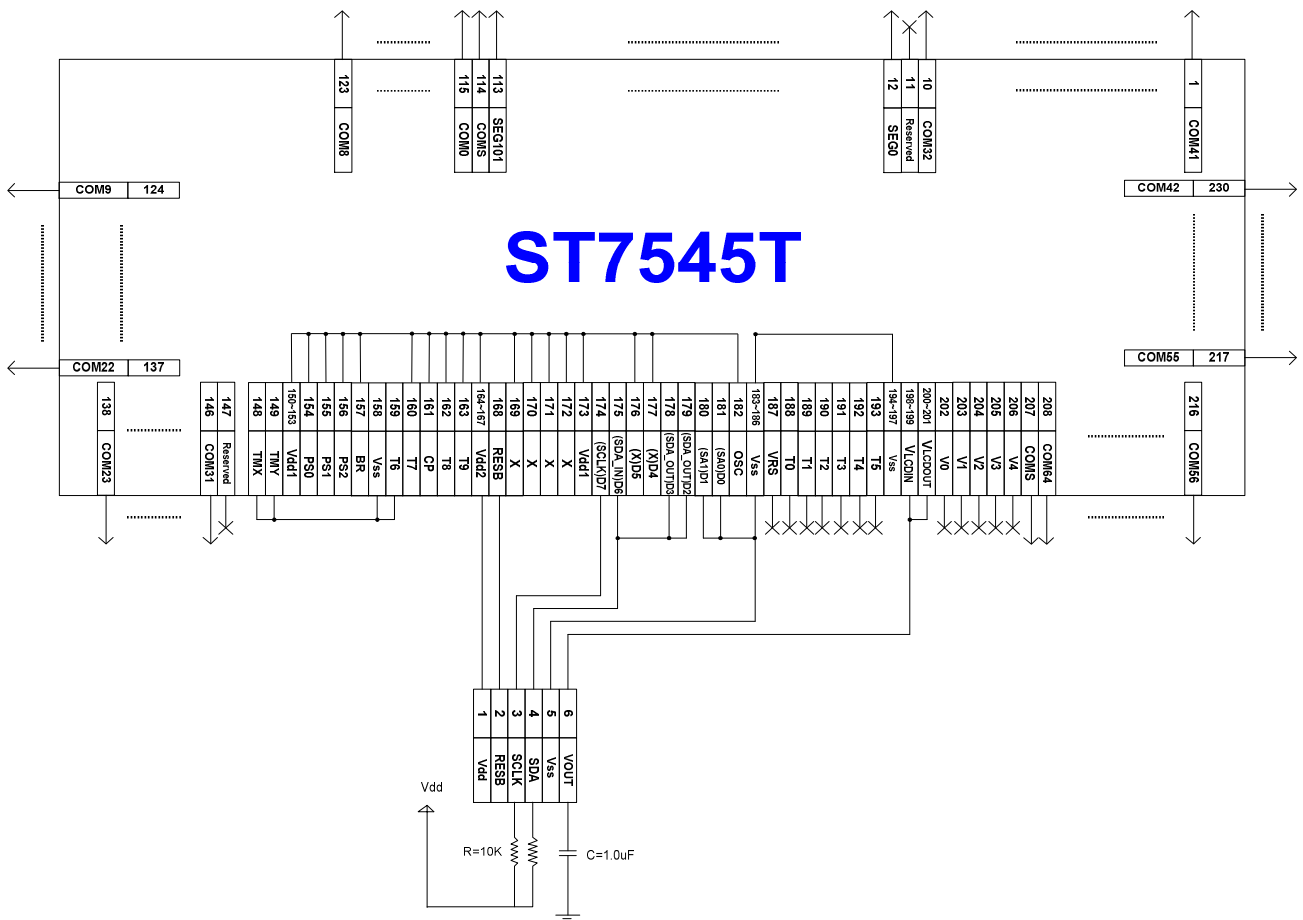
History

Version	History	Notes
V0.x	Preliminary	
V1.1	1. Complete release 2. Revise I2C pin description 3. Modify description.	2005/10/19
V1.2	1. Modify pixel order on Page 23.	2005/10/26
V1.3	1. Modify Feature Description.	2005/11/18
V1.4	2. Update Frame Rate Range.	2006/01/12
V1.5	1. Change Dice Thickness and Part Number (ST7545T-G2).	2006/01/20